

Product Description

Qorvo’s QPA1010 is a X-band high power MMIC amplifier fabricated on Qorvo’s production 0.15um GaN on SiC process (QGaN15). The QPA1010 operates from 7.9 – 11 GHz and typically provides 15 W saturated output power with power-added efficiency of 38% and large-signal gain of 18 dB. This combination of wideband performance provides the flexibility designers are looking for to improve system performance while reducing size and cost.

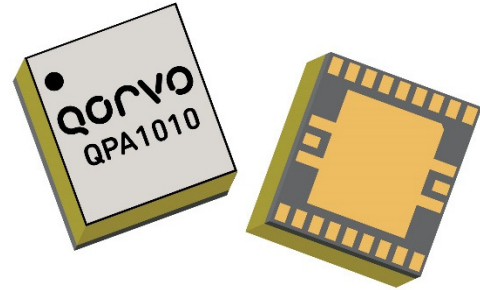
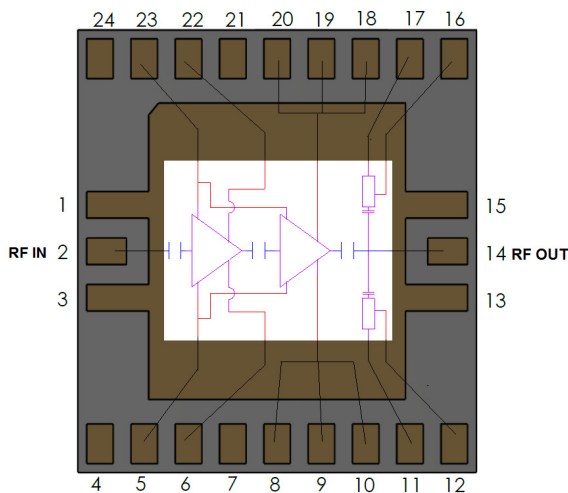
QPA1010 can also support a variety of operating conditions to best support system requirements. With good thermal properties, it can support a range of bias voltages and will perform well under both CW and pulse operations.

The QPA1010 is matched to 50Ω with integrated DC blocking capacitors on both RF I/O ports simplifying system integration. The wideband performance and operational flexibility allows it support satellite communication and data links, as well as, military and commercial radar systems.

Lead-free and RoHS compliant.

Evaluation boards are available upon request.

Functional Block Diagram



Product Features

- Frequency Range: 7.9–11 GHz
- P_{OUT}: 42 dBm at P_{IN} = 24 dBm
- PAE: 38 % at P_{IN} = 24 dBm
- Large Signal Gain: 18 dB at P_{IN} = 24 dBm
- Small Signal Gain: 25 dB
- Integrated Power Detector
- Bias: V_D = 24 V, I_{DQ} = 600 mA, V_G = -1.8 V Typical
- Pulsed V_D: PW = 100 μS, DC = 10%
- Package Dimensions: 4.5 x 5.0 x 1.72 mm

Performance is typical across frequency. Please reference electrical specification table and data plots for more details.

Applications

- Satellite Communications
- Data Links
- Military and Commercial Radar

Ordering Information

| Part No. | ECCN | Description |
|----------|---------------|------------------------------------|
| QPA1010 | 3A001.b.2.b.2 | 7.9–11 GHz 15W GaN Power Amplifier |

Absolute Maximum Ratings

| Parameter | Value / Range |
|---|-------------------|
| Drain Voltage (V_D) | 29.5 V |
| Gate Voltage Range (V_G) | -8 to 0V |
| Drain Current (I_{D1}/I_{D2}) | 672 mA / 1440 mA |
| Gate Current (I_G) | See chart, pg. 20 |
| Power Dissipation (P_{DISS}), 85 °C, CW | 38 W |
| Input Power (P_{IN}), CW, 50Ω, $V_D=28$ V, $I_{DQ}=600$ mA, 85 °C | 30 dBm |
| Input Power (P_{IN}), CW, VSWR 3:1, $V_D=28$ V, $I_{DQ}=600$ mA 85 °C | 30 dBm |
| Channel Temperature (T_{CH}) | 275 °C |
| Mounting Temperature (30 seconds) | 260 °C |
| Storage Temperature | -55 to 150 °C |

Operation of this device outside the parameter ranges given above may cause permanent damage. These are stress ratings only, and functional operation of the device at these conditions is not implied.

Electrical Specifications

| Parameter | | Min | Typ | Max | Units |
|--|----------|-----|--------|-----|-------|
| Operational Frequency Range | | 7.9 | | 11 | GHz |
| Output Power ($P_{IN} = 24$ dBm) | 7.9 GHz | | 41.7 | | dBm |
| | 9.0 GHz | | 42.3 | | dBm |
| | 11.0 GHz | | 41.8 | | dBm |
| Power Added Efficiency ($P_{IN} = 24$ dBm) | 7.9 GHz | | 37.7 | | % |
| | 9.0 GHz | | 38.6 | | % |
| | 11.0 GHz | | 37.3 | | % |
| 3 rd Order Intermodulation Level ($P_{OUT}/Tone = 35$ dBm) | 7.9 GHz | | -21 | | dBc |
| | 10.0 GHz | | -21 | | dBc |
| | 11.0 GHz | | -22 | | dBc |
| Small Signal Gain | 7.9 GHz | | 27.9 | | dB |
| | 9.0 GHz | | 27.8 | | dB |
| | 11.0 GHz | | 26.0 | | dB |
| Input Return Loss | 7.9 GHz | | 17 | | dB |
| | 9.0 GHz | | 22 | | dB |
| | 11.0 GHz | | 21 | | dB |
| Output Return Loss | 7.9 GHz | | 11 | | dB |
| | 9.0 GHz | | 11 | | dB |
| | 11.0 GHz | | 18 | | dB |
| Output Power Temperature Coefficient (25–85 °C) ($P_{IN} = 24$ dBm) | | | -0.003 | | dB/°C |
| Small Signal Gain Temperature Coefficient (25–85 °C) | | | -0.044 | | dB/°C |
| Recommended Voltage Operations | | | 24 | 28 | V |

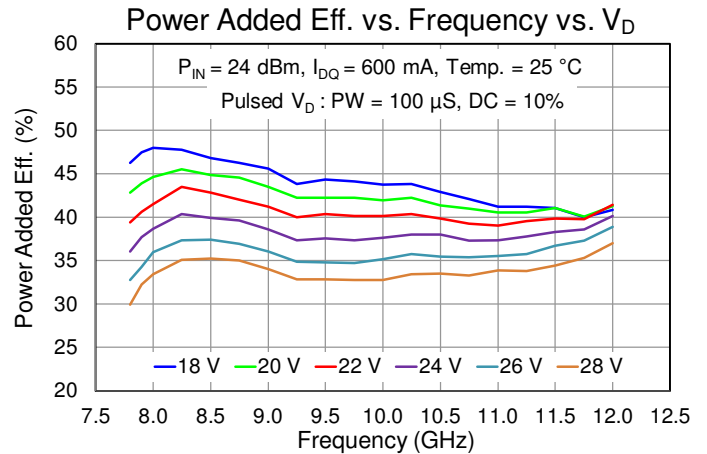
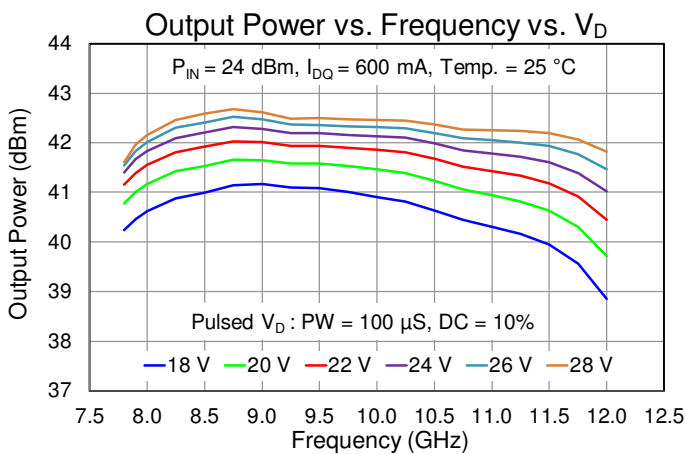
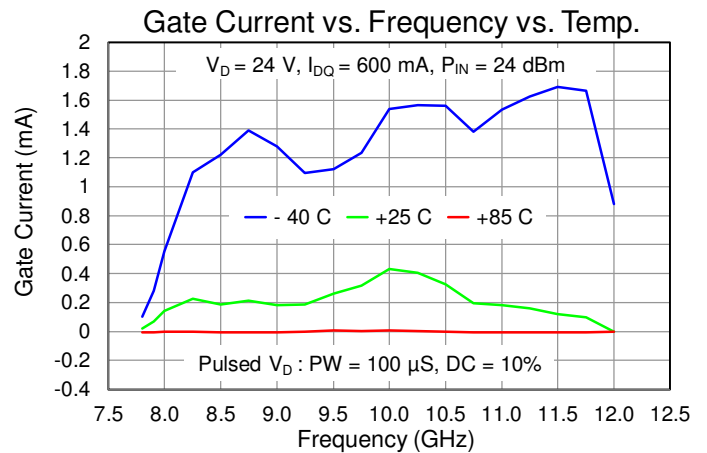
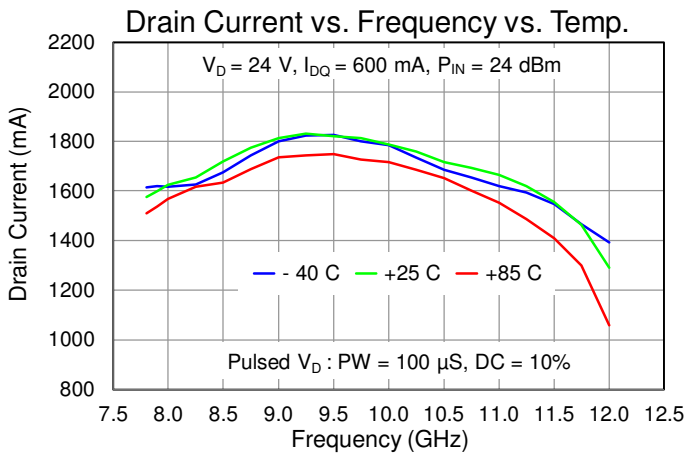
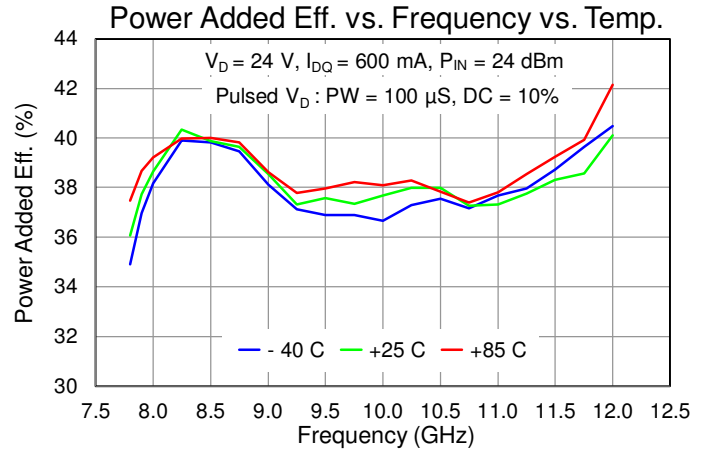
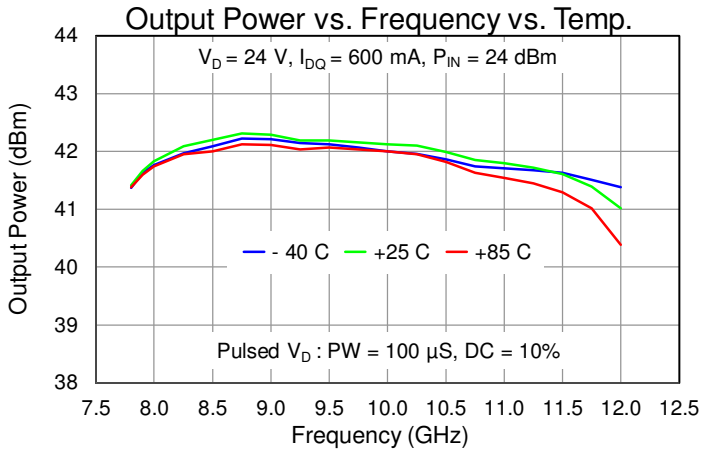
Test conditions, unless otherwise noted: 25 °C, Pulsed V_D : PW = 100 μS, DC = 10%, $V_D = 24$ V, $I_{DQ} = 600$ mA, $V_G = -1.8$ V Typical

Recommended Operating Conditions

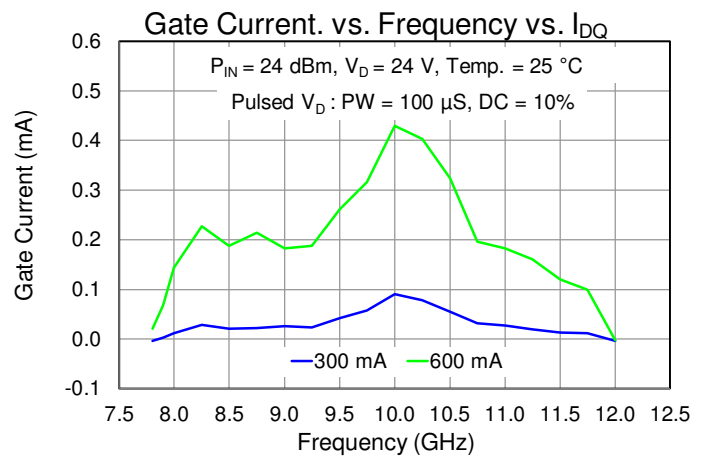
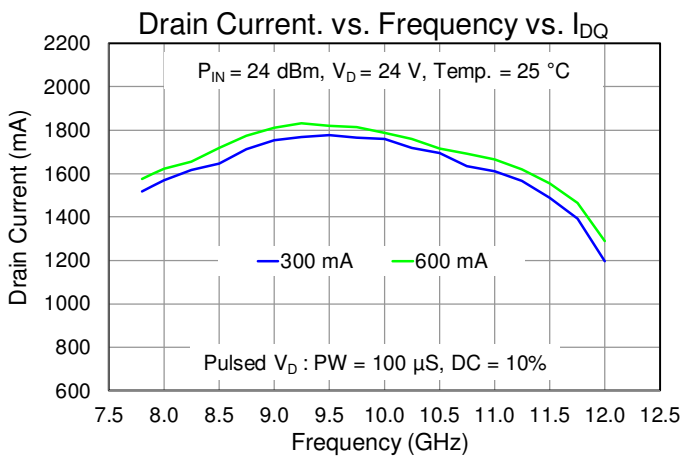
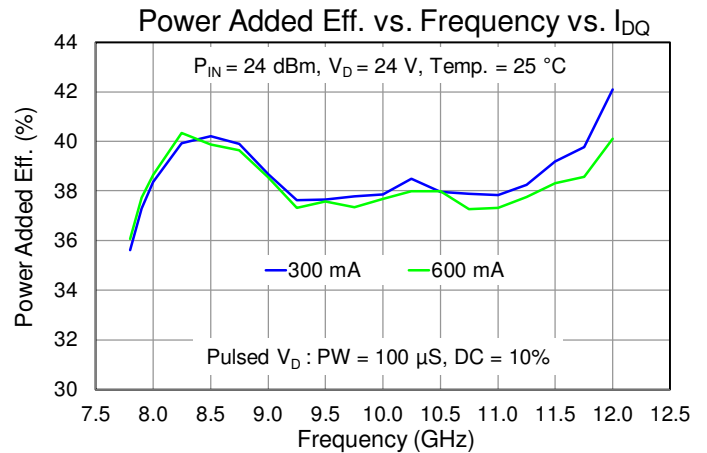
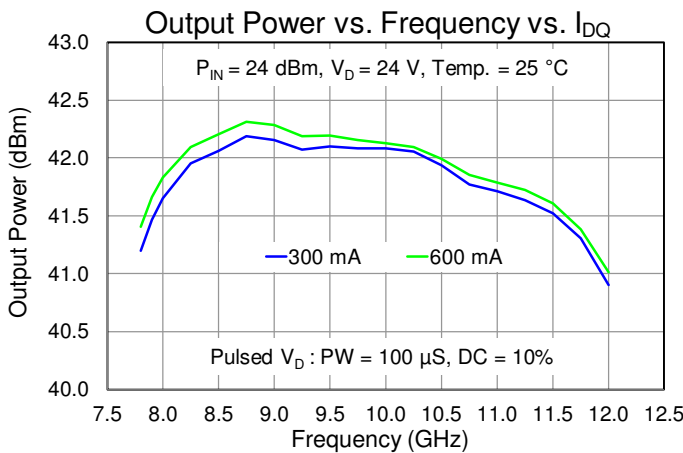
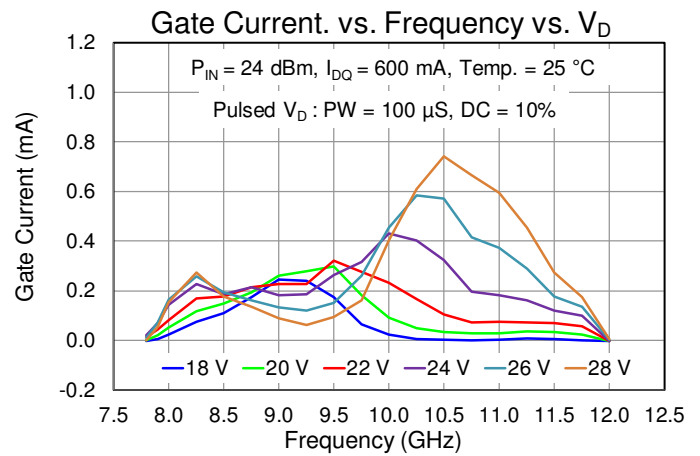
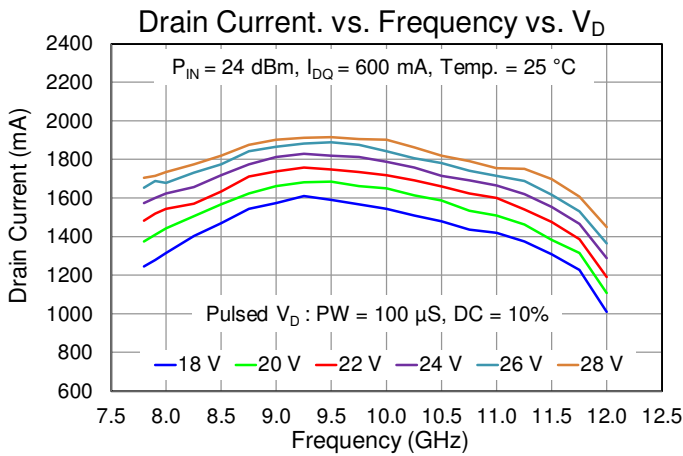
| Parameter | Value / Range |
|---------------------------------|---------------|
| Drain Voltage (V_D) | 24 V |
| Drain Current (I_{DQ}) | 600 mA |
| Gate Voltage (V_G), Typical | -1.8 V |

Electrical specifications are measured at specified test conditions. Specifications are not guaranteed over all recommended operating conditions.

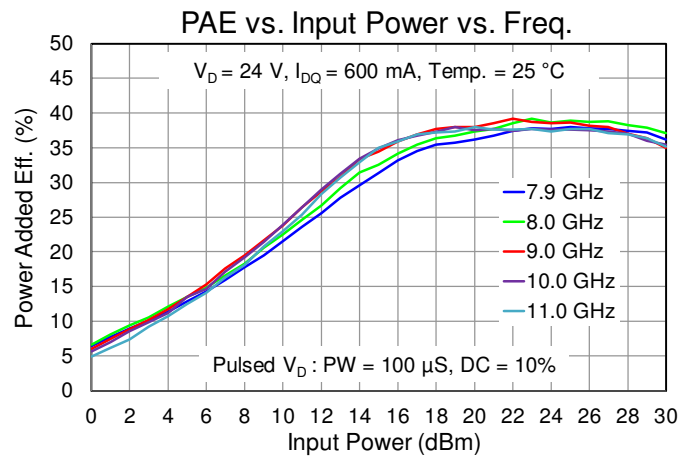
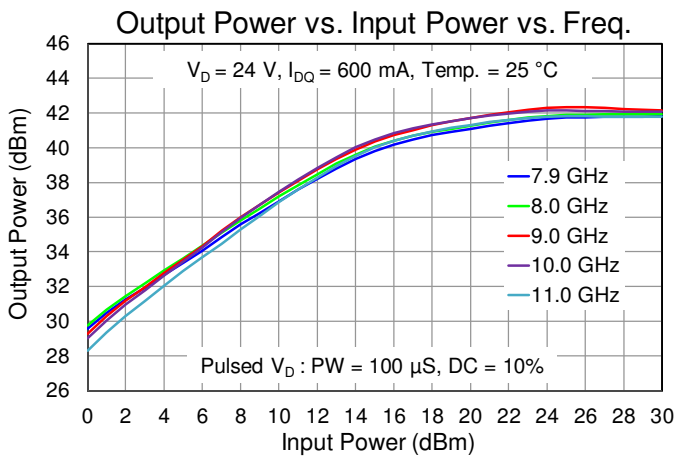
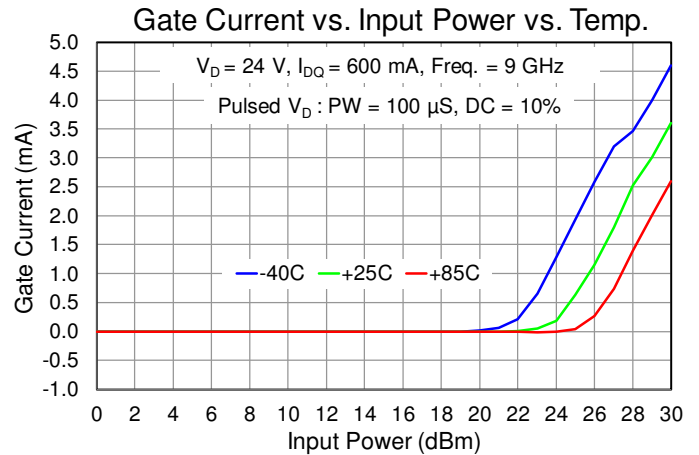
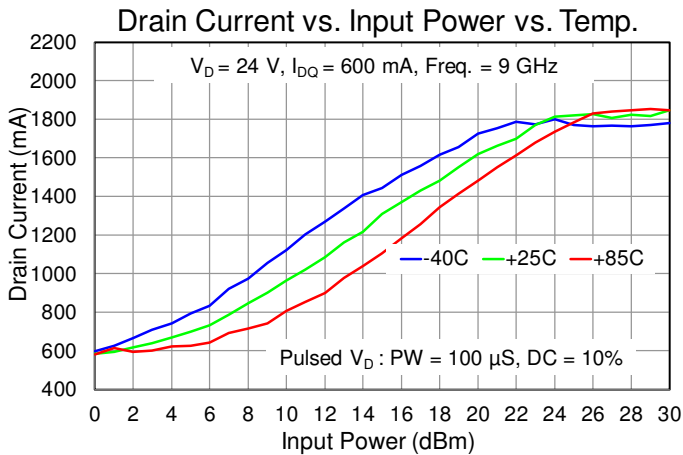
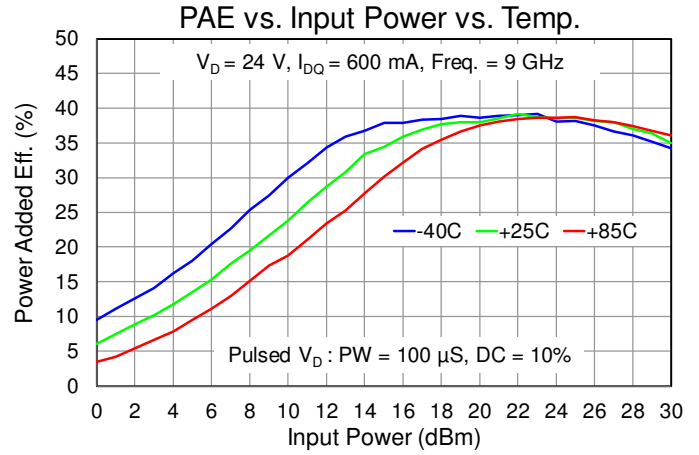
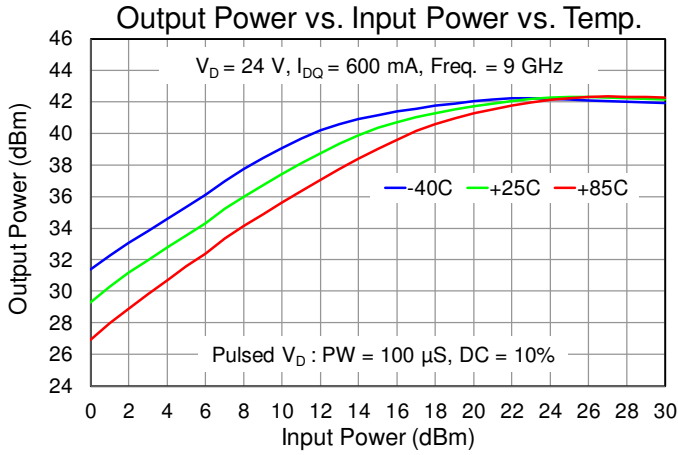
Performance Plots – Large Signal (Pulsed)



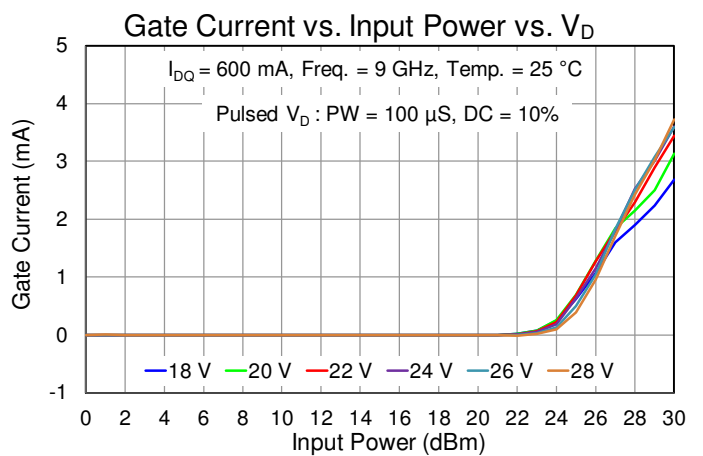
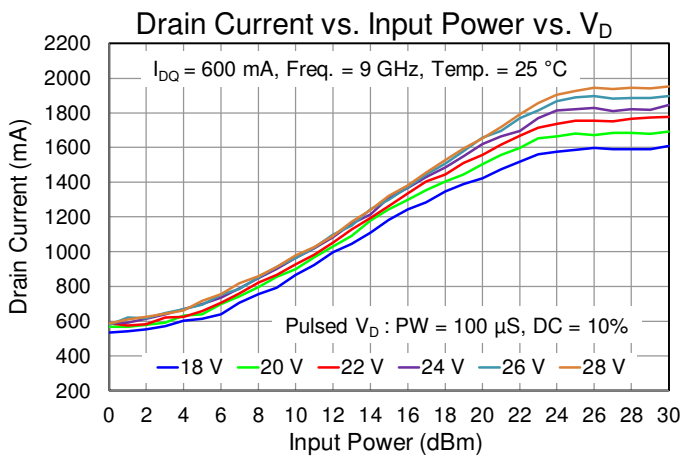
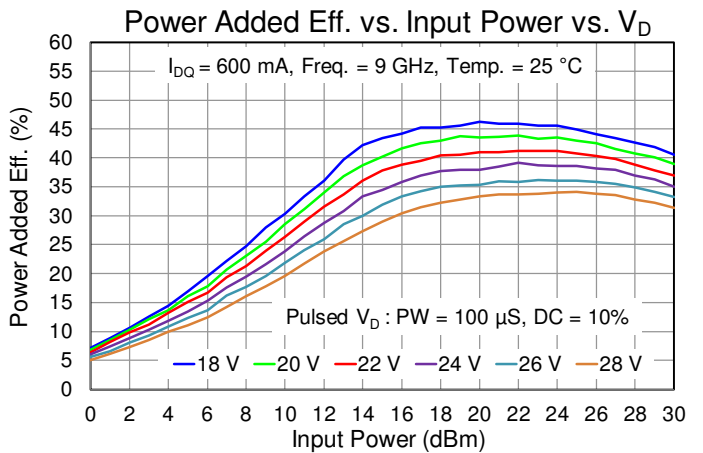
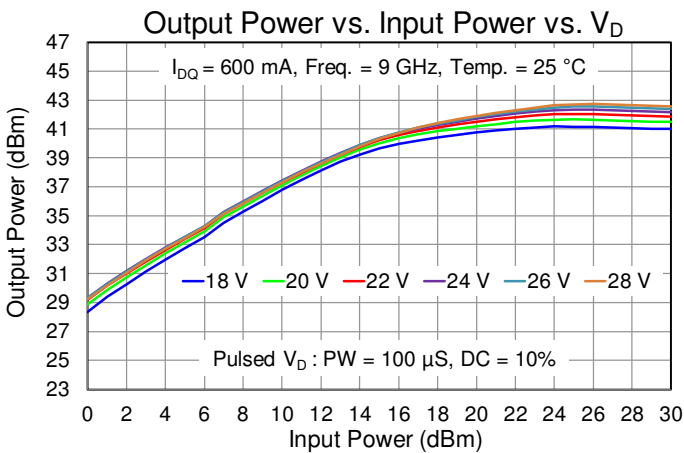
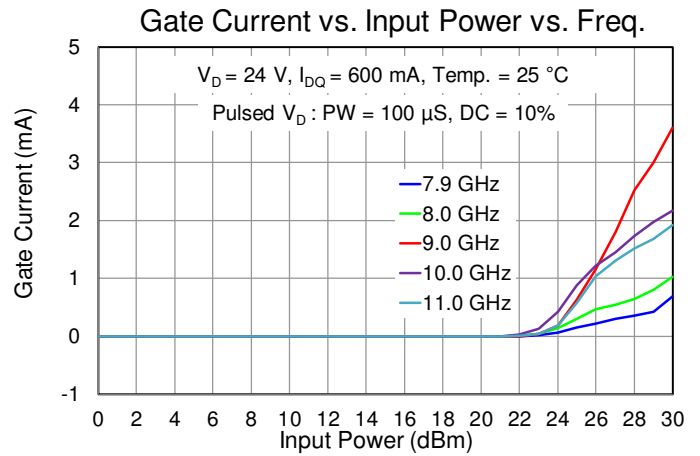
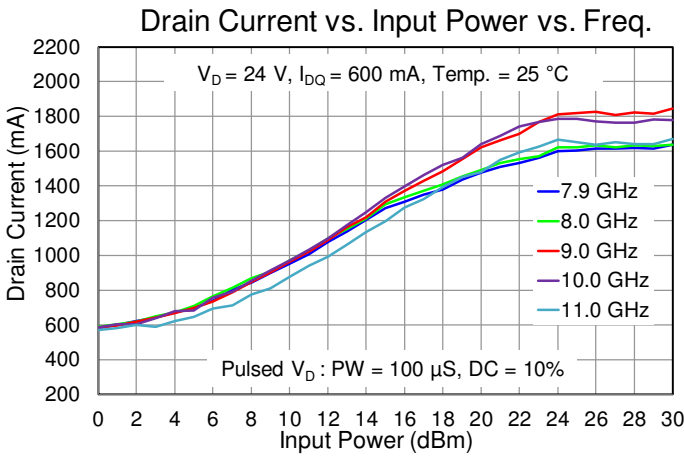
Performance Plots – Large Signal (Pulsed)



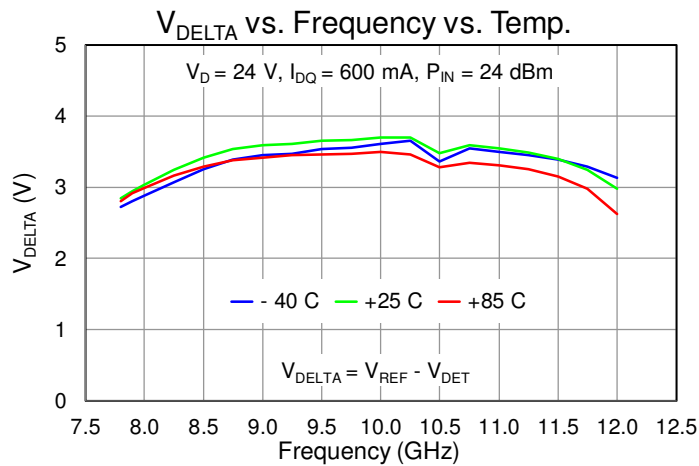
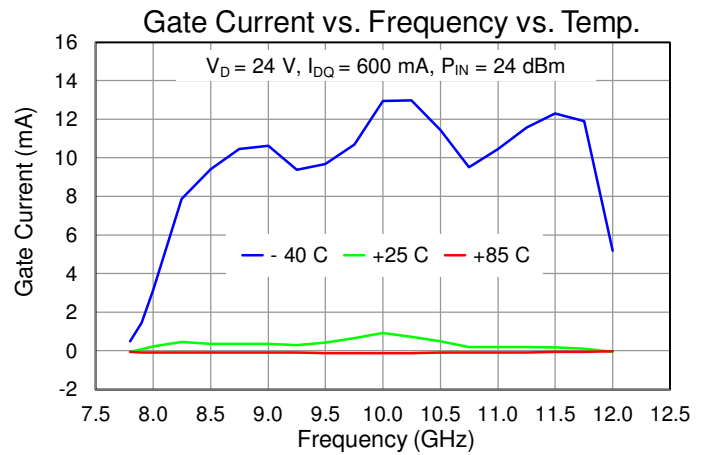
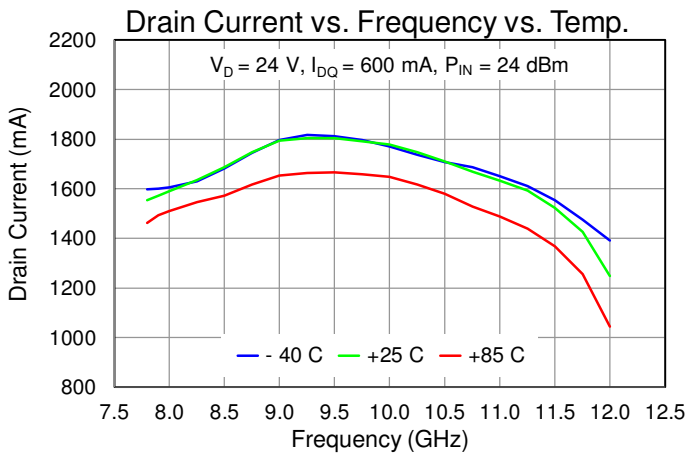
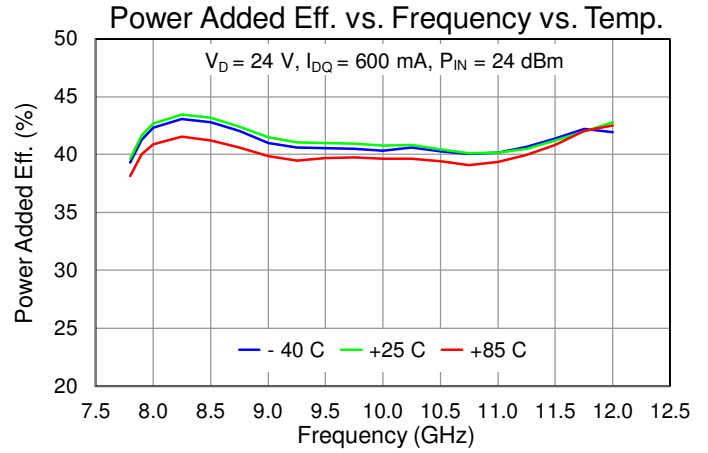
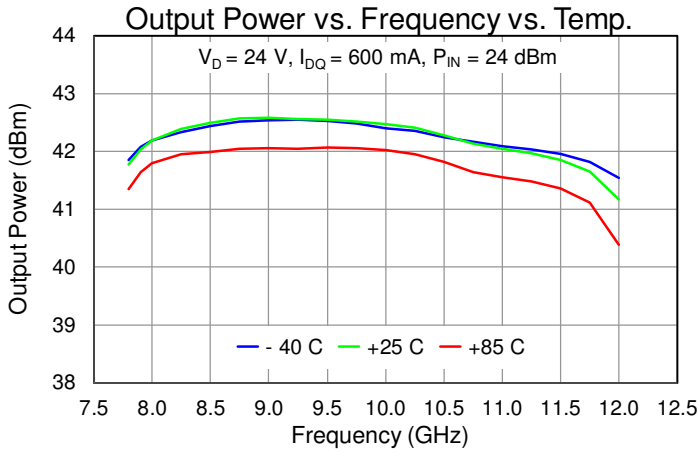
Performance Plots – Large Signal (Pulsed)



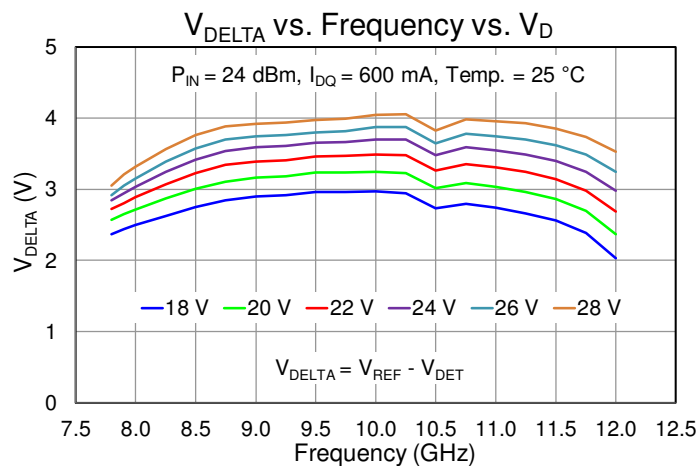
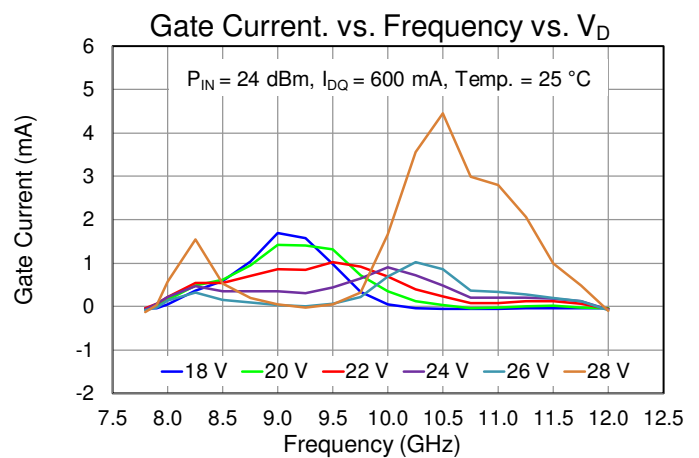
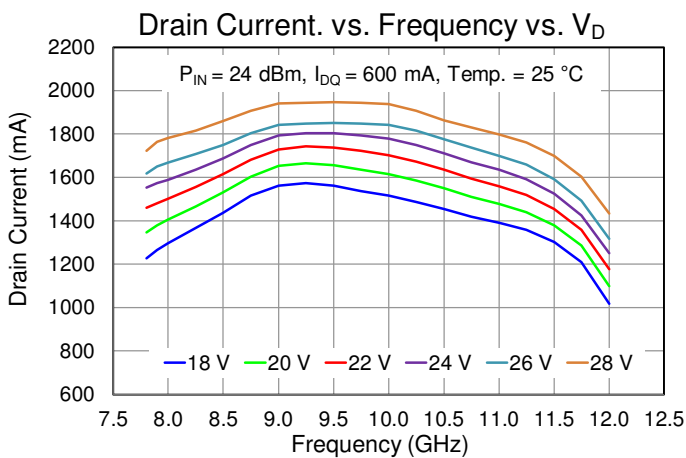
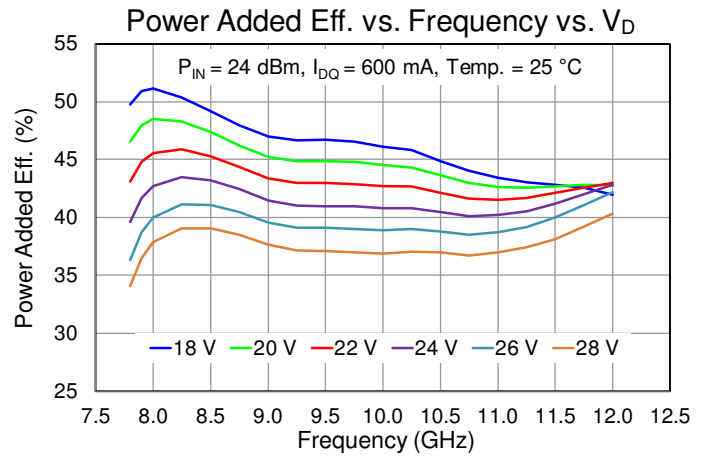
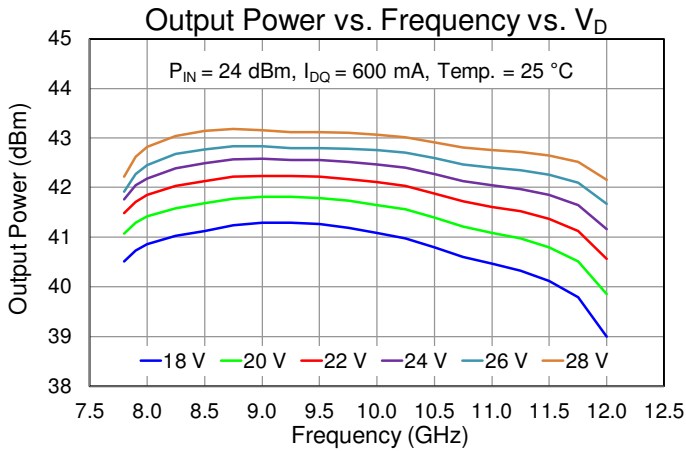
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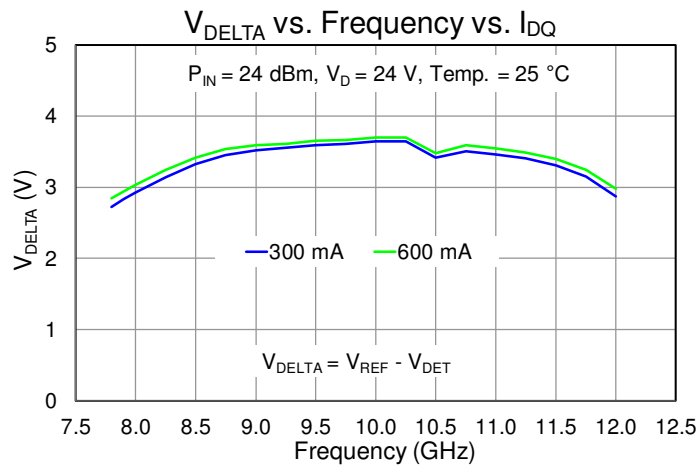
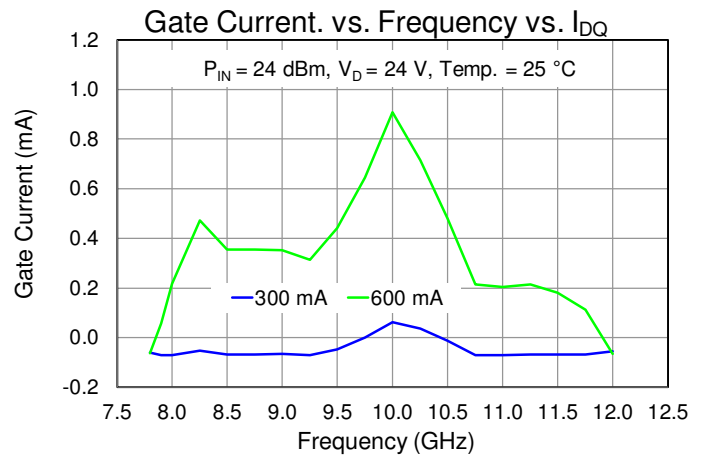
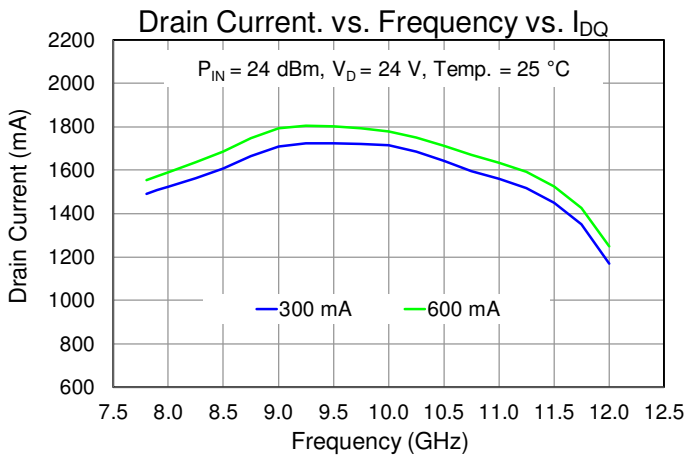
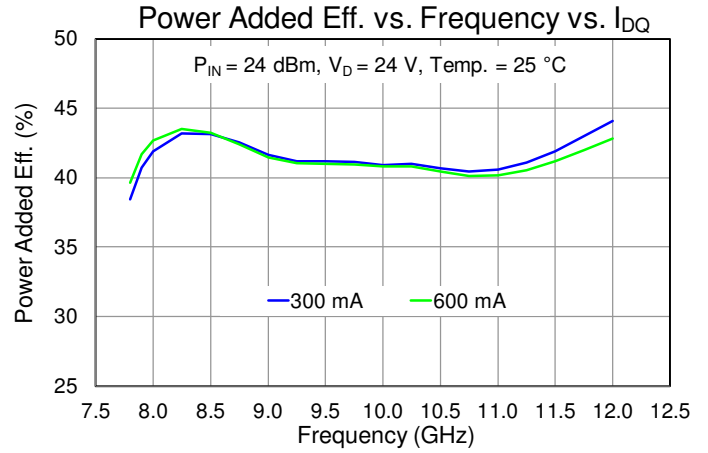
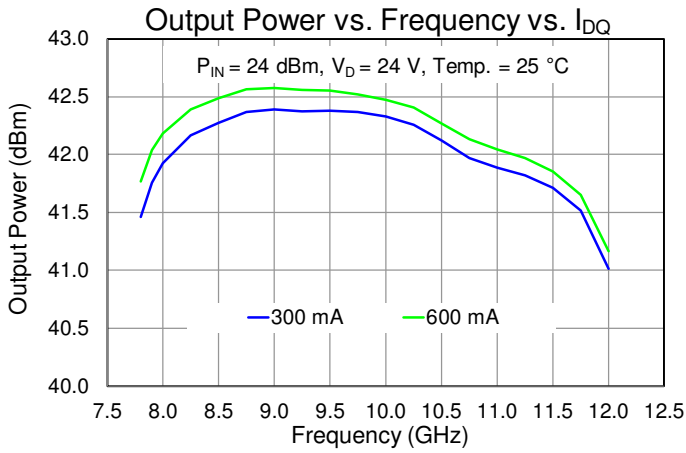
Performance Plots – Large Signal (CW)



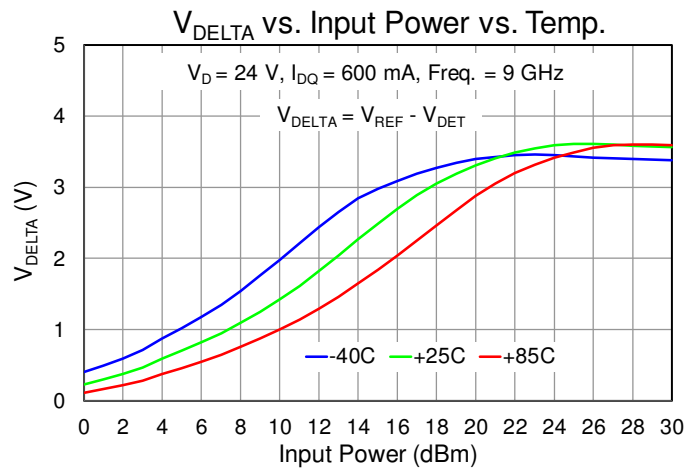
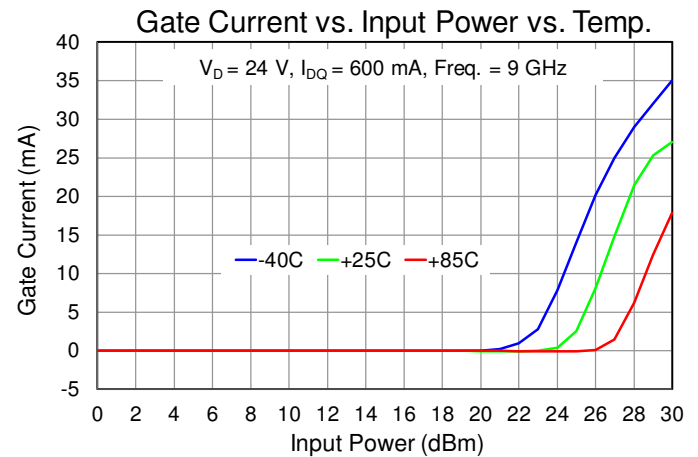
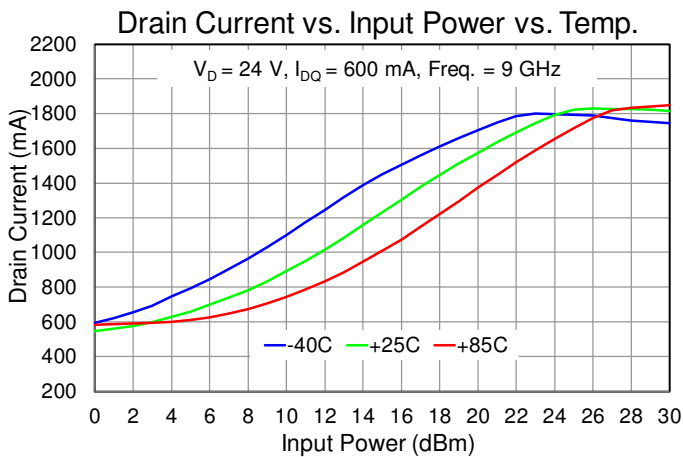
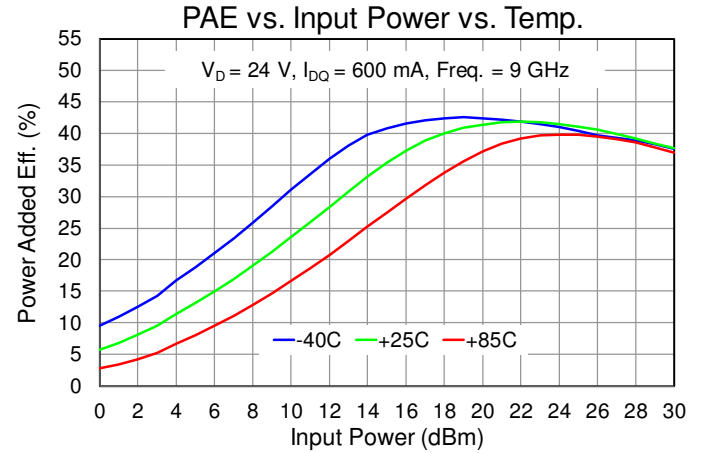
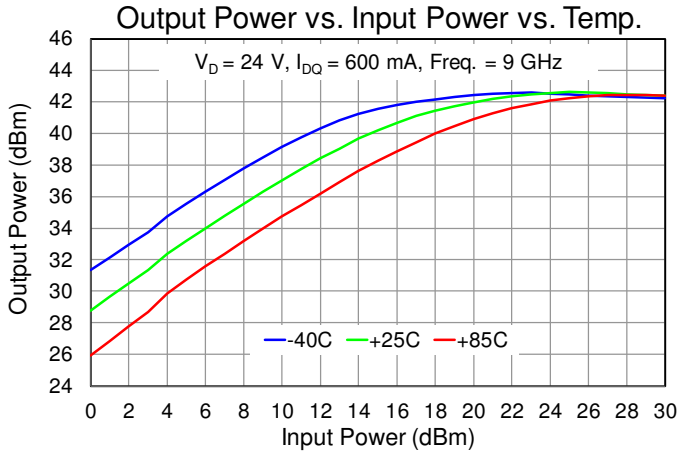
Performance Plots – Large Signal (CW)



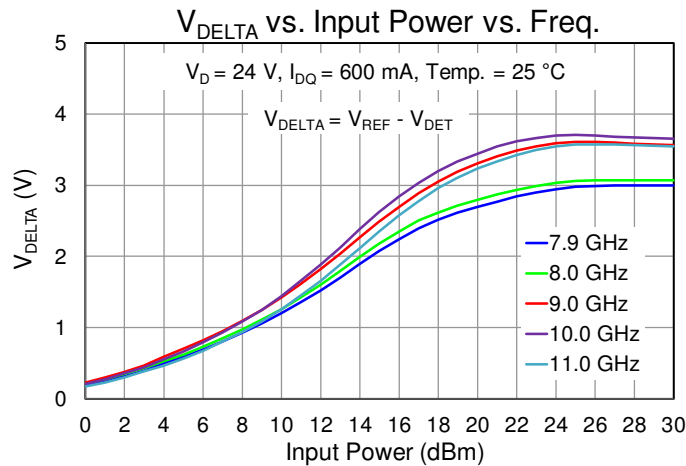
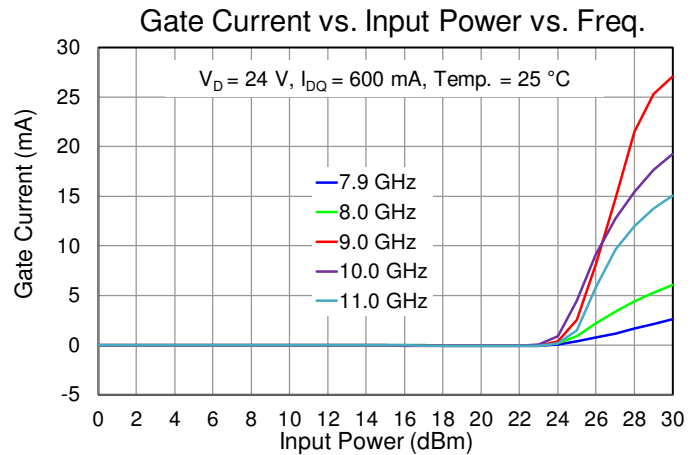
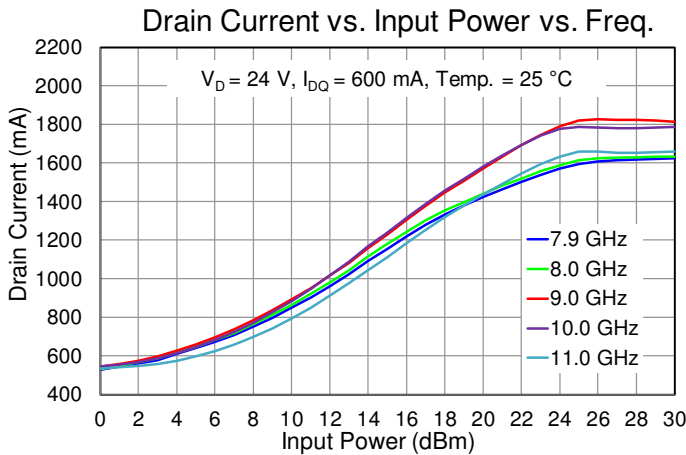
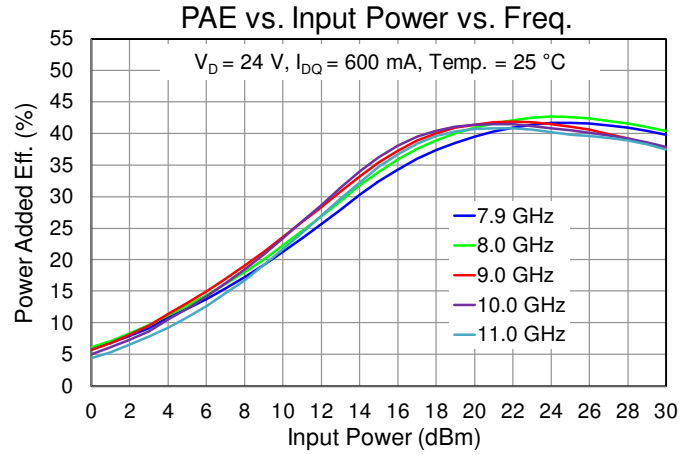
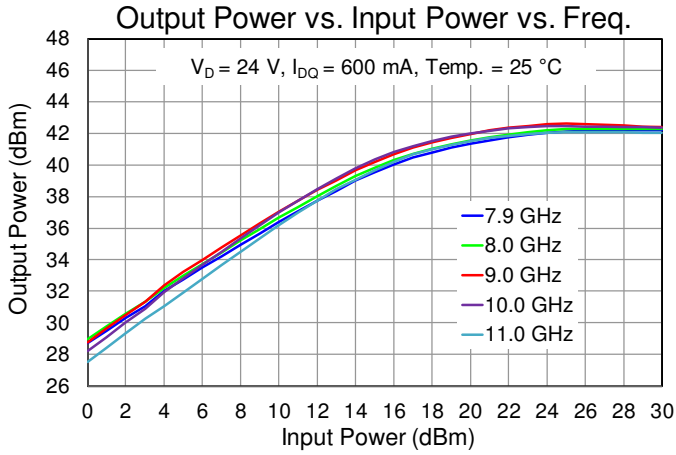
Performance Plots – Large Signal (CW)



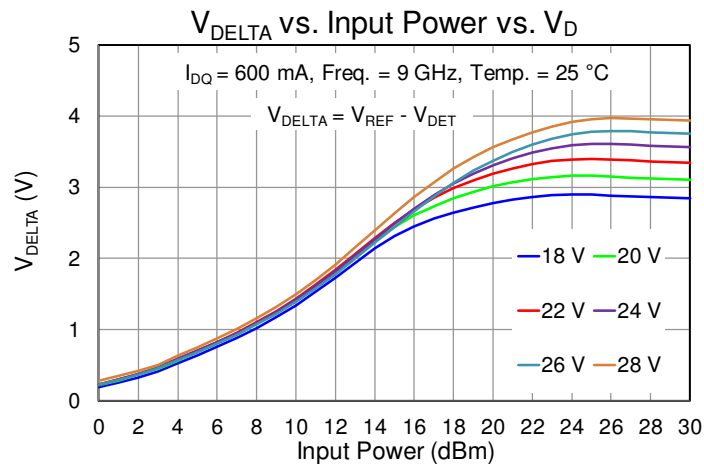
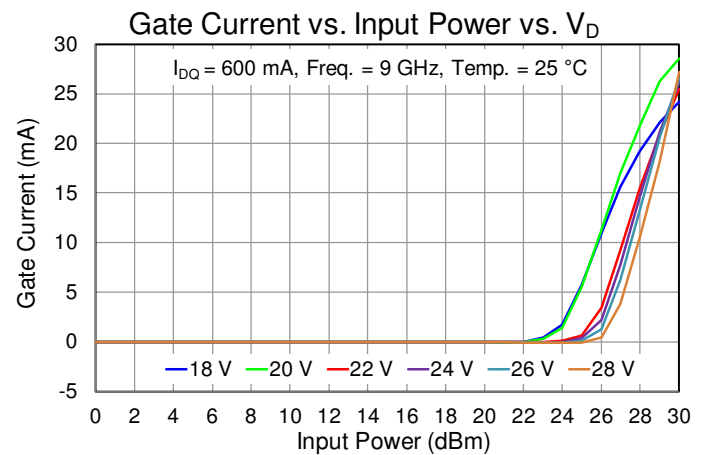
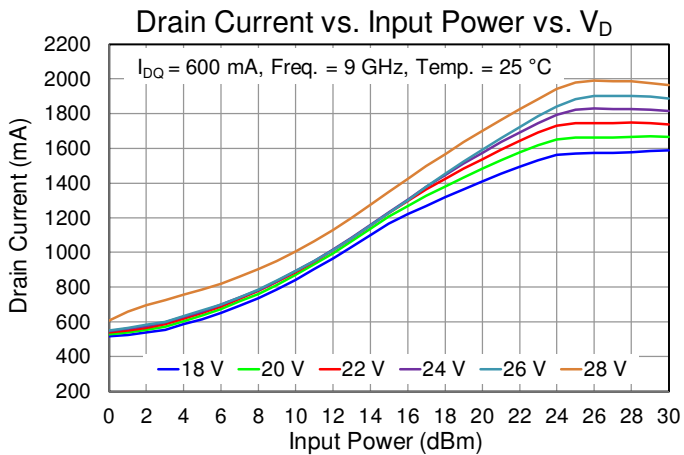
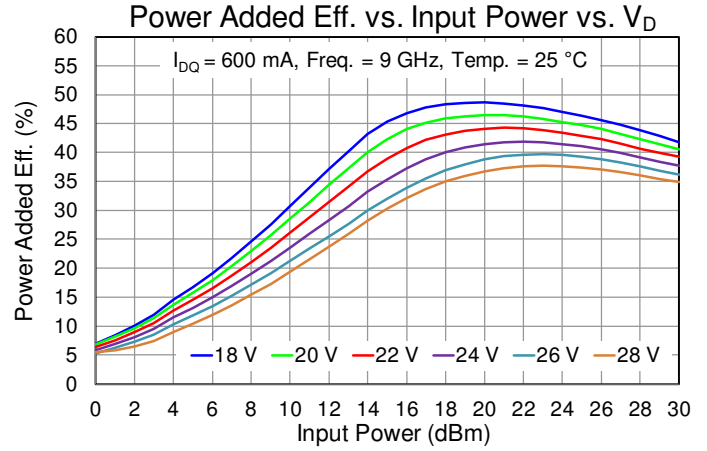
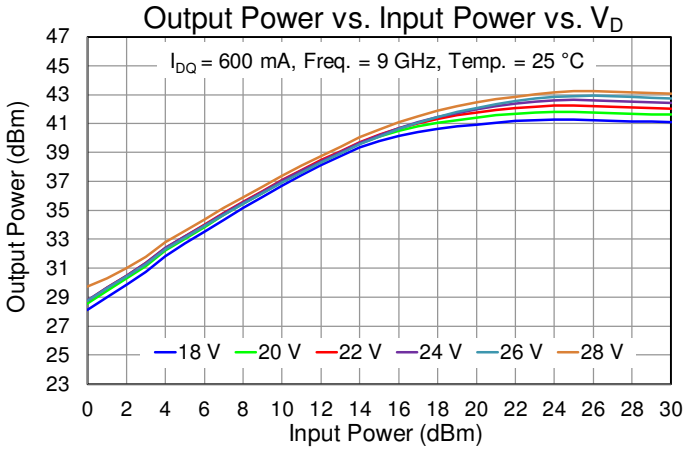
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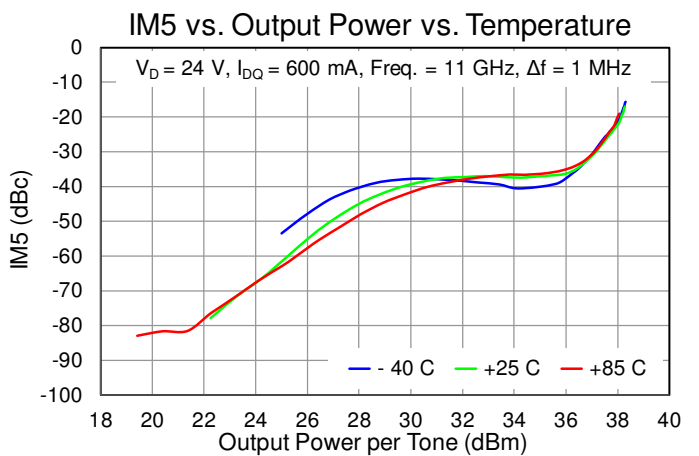
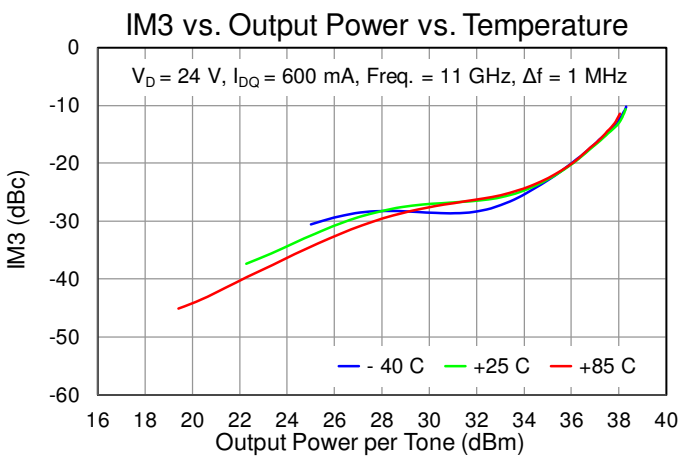
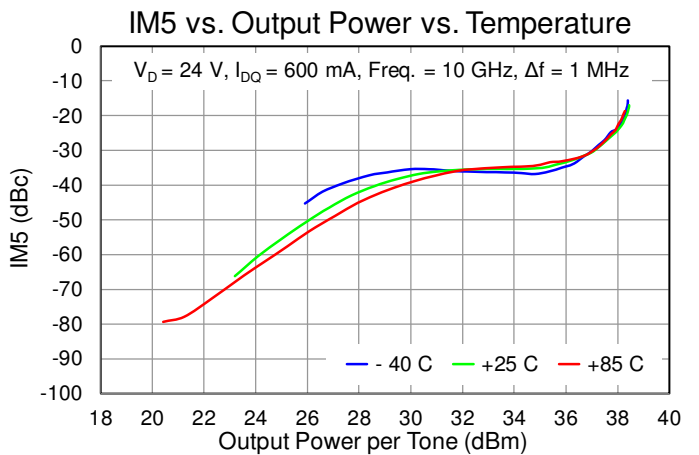
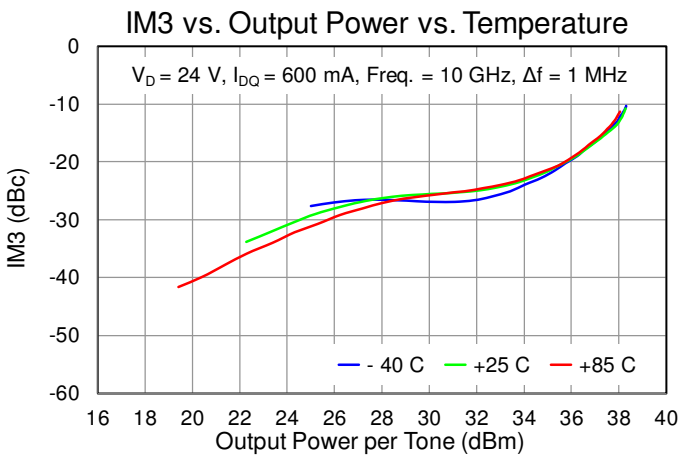
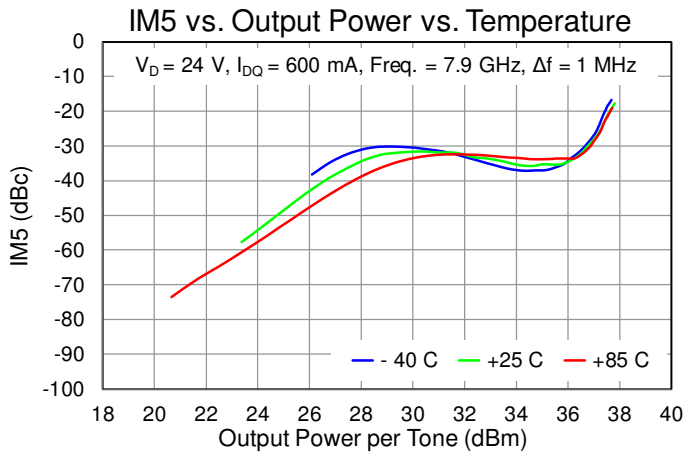
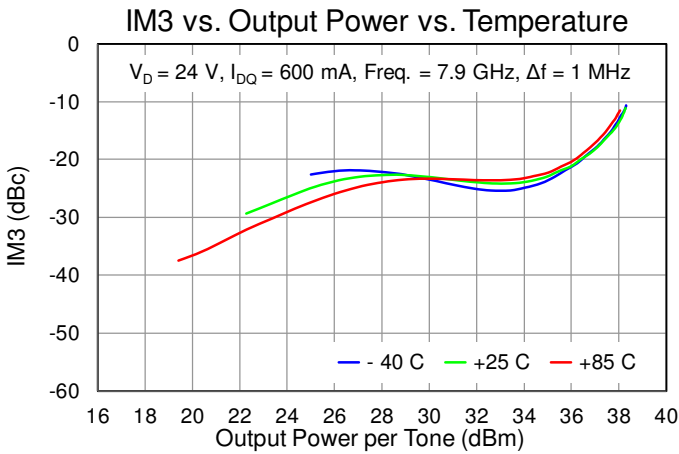
Performance Plots – Large Signal (CW)



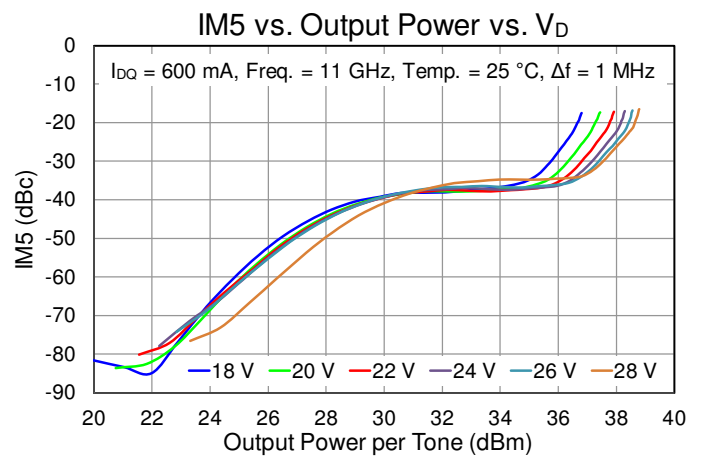
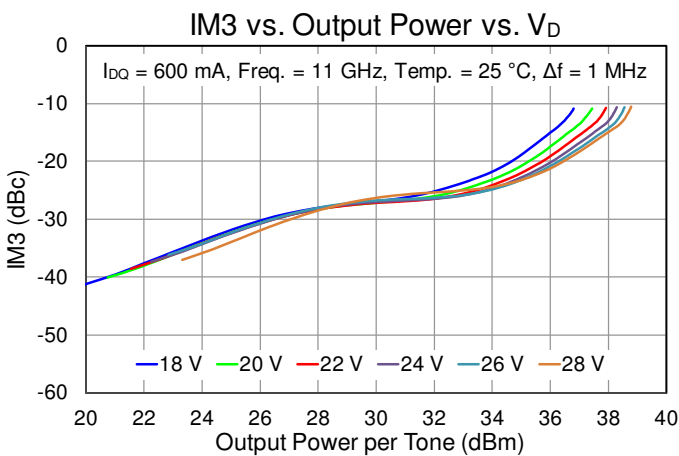
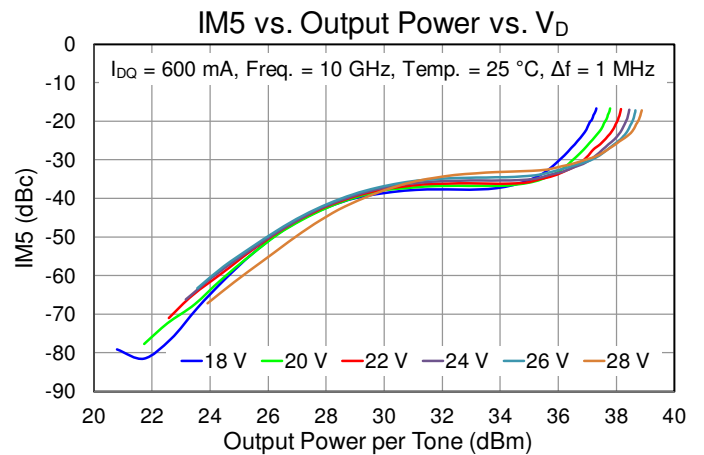
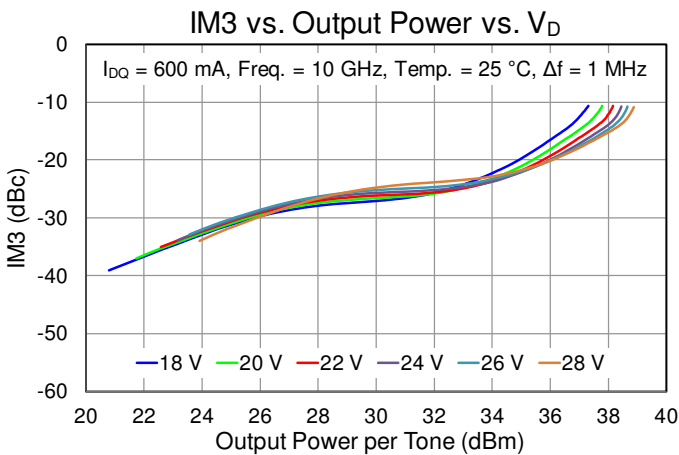
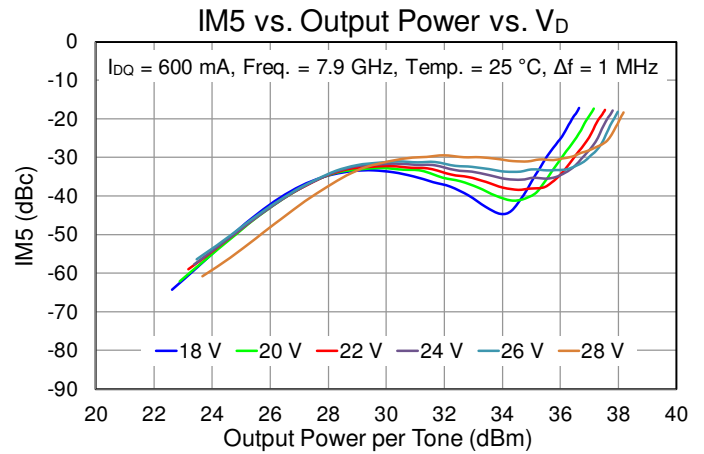
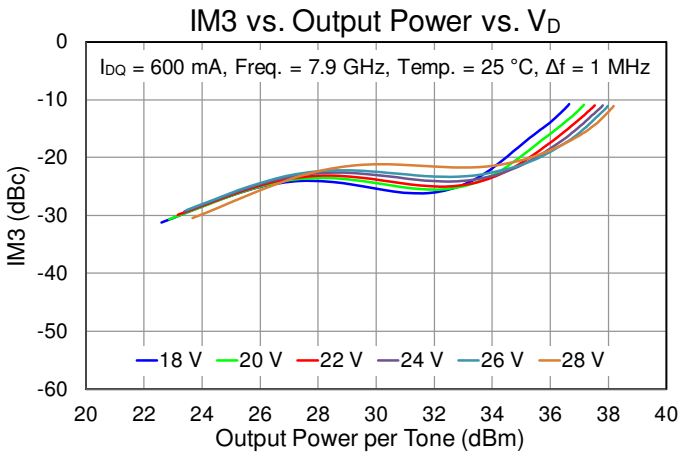
Performance Plots – Large Signal (CW)



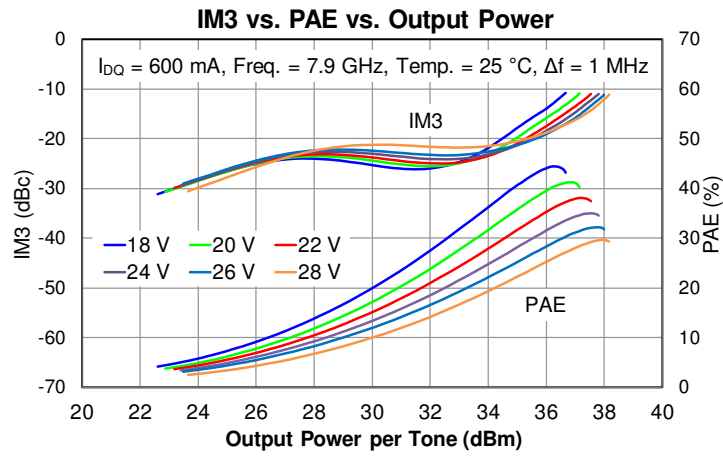
Performance Plots – Linearity



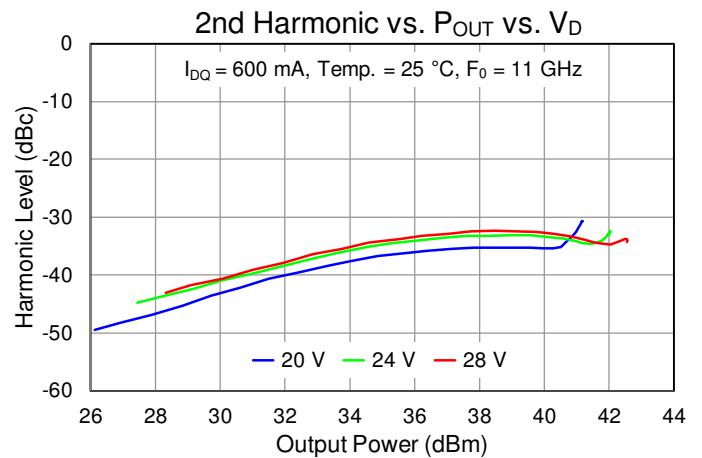
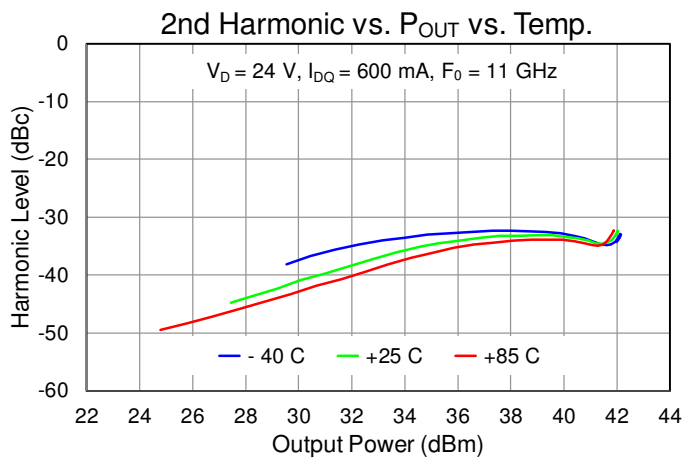
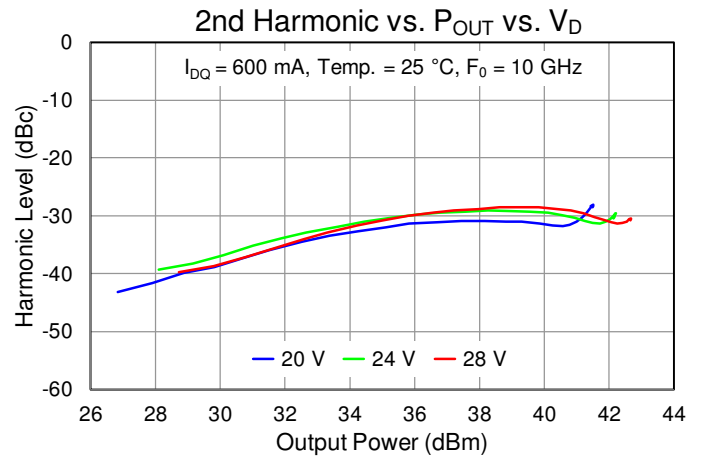
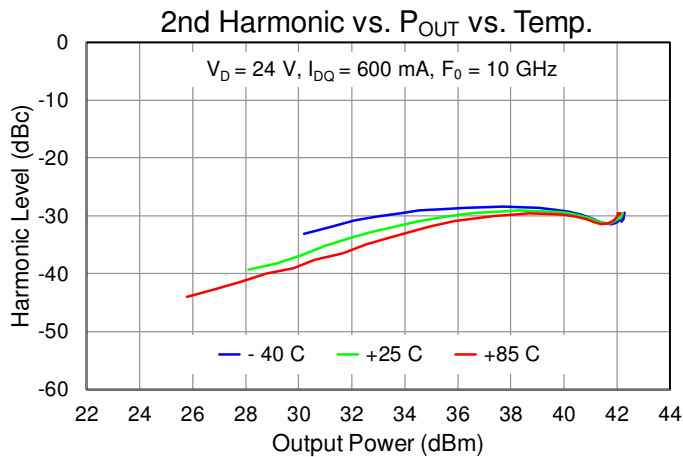
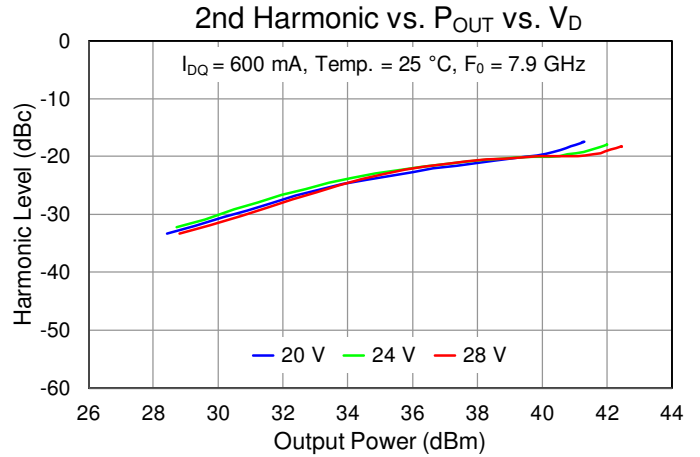
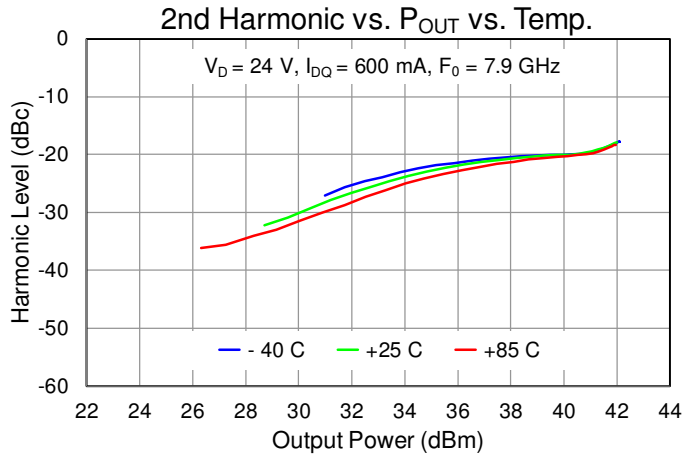
Performance Plots – Linearity



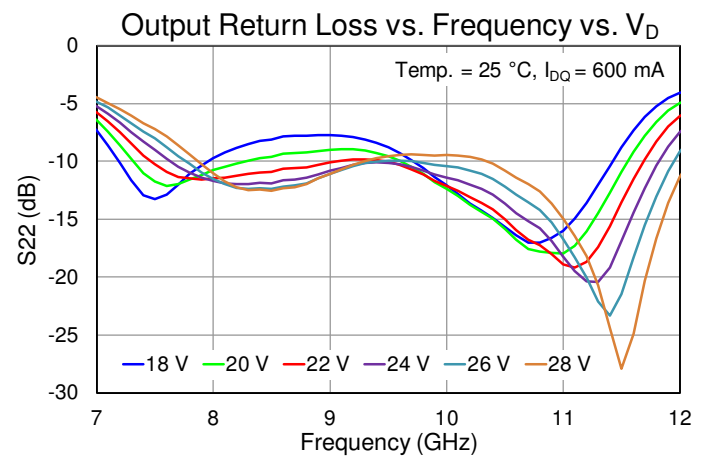
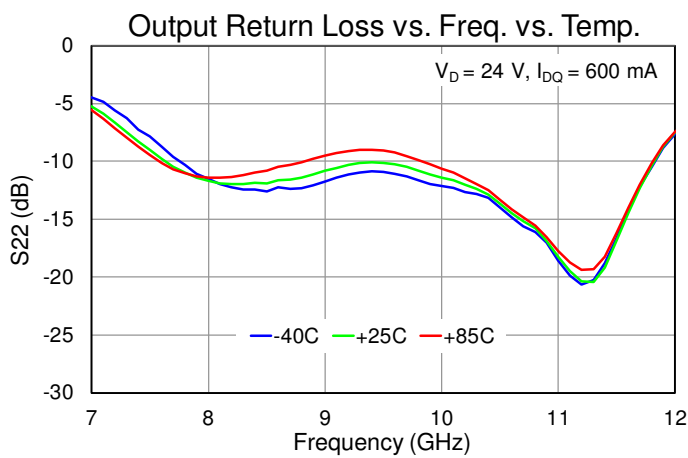
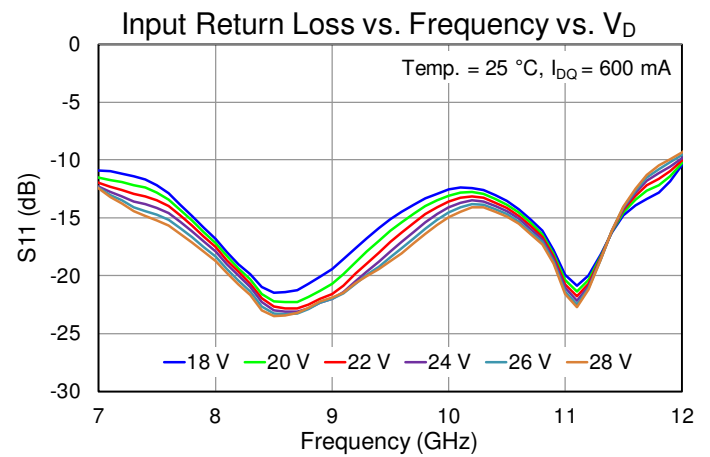
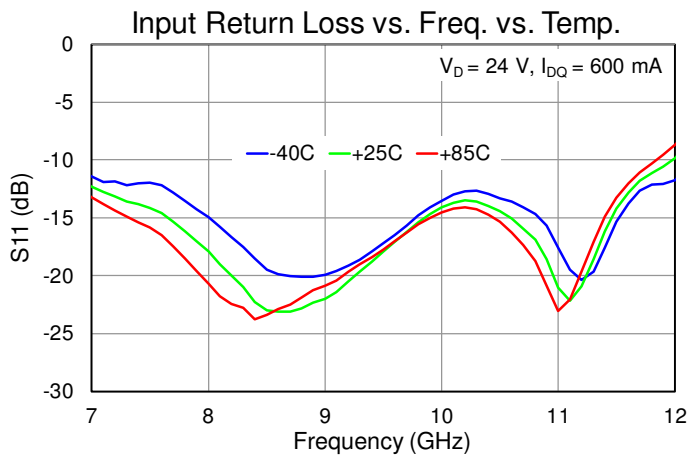
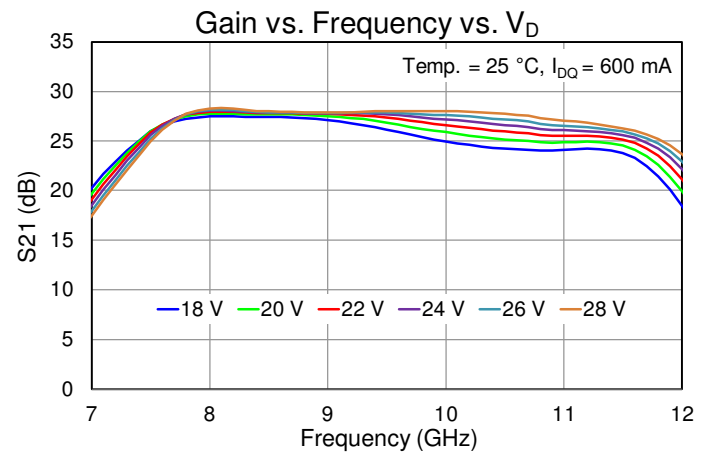
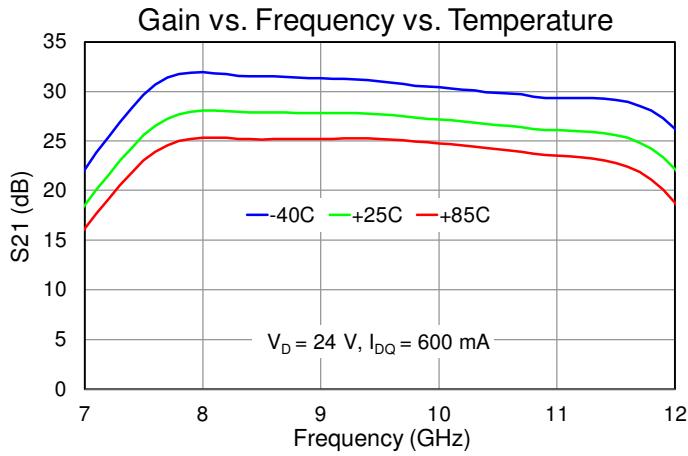
Performance Plots – Linearity



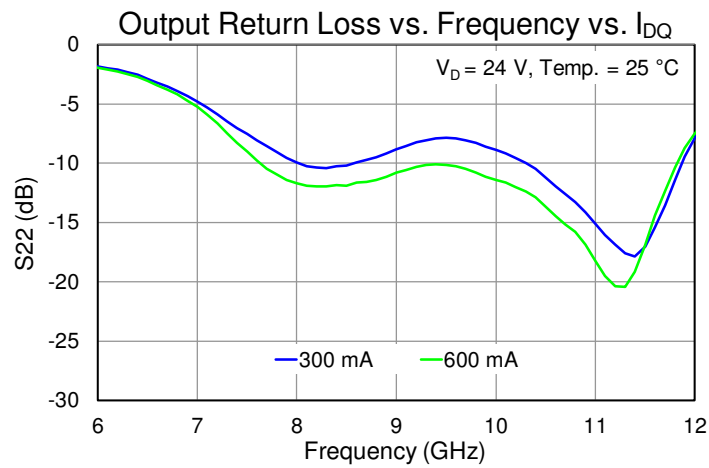
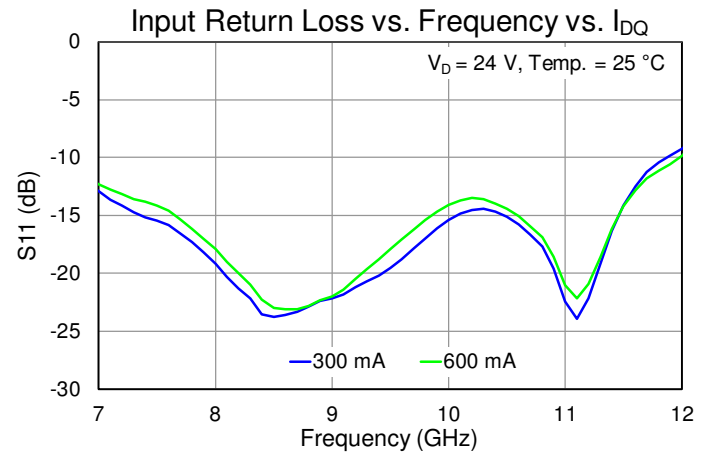
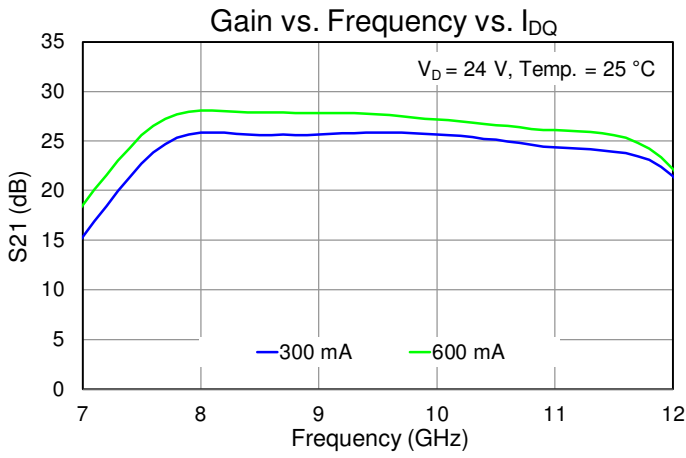
Performance Plots – Harmonics



Performance Plots – Small Signal



Performance Plots – Small Signal



Thermal and Reliability Information

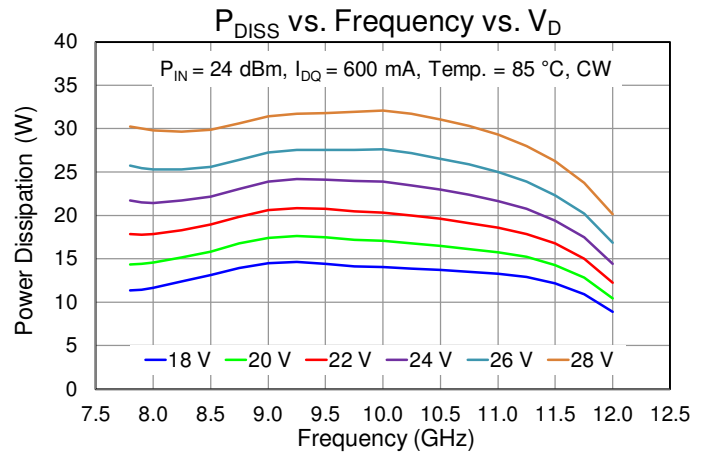
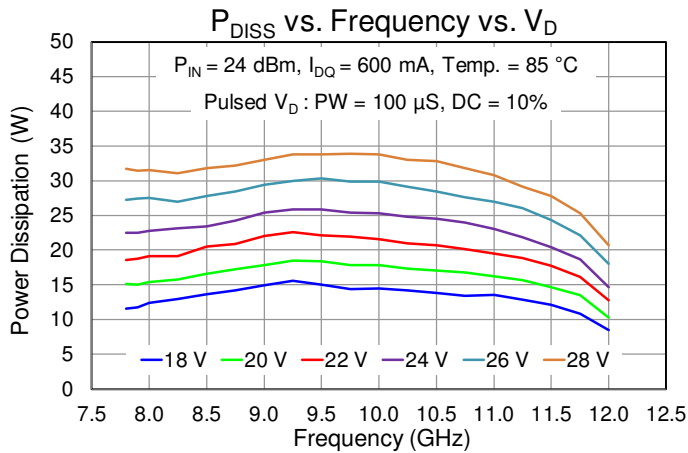
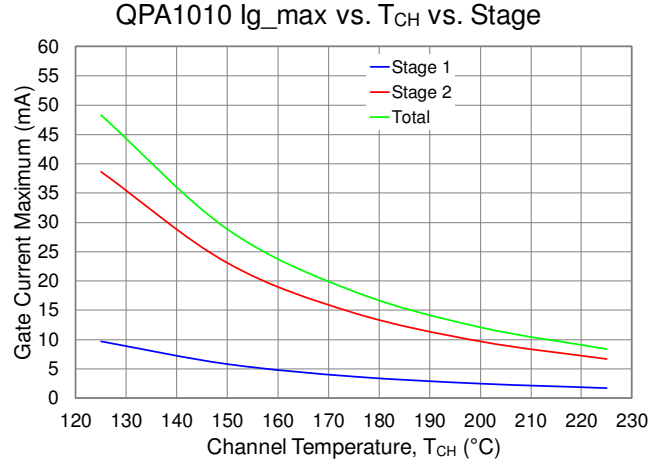
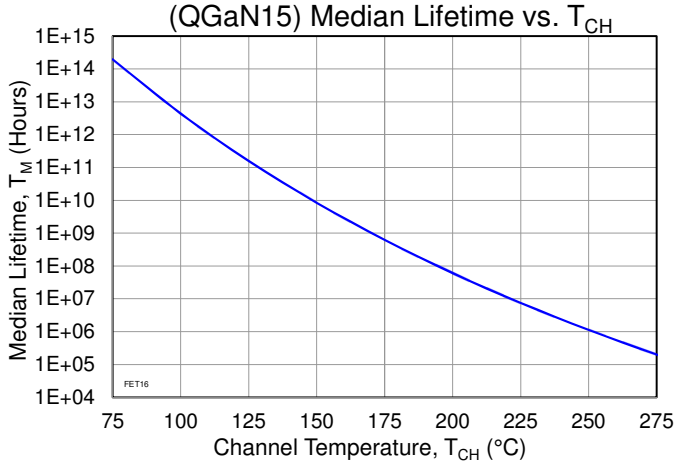
| Parameter | Test Conditions | Value | Units |
|---|---|----------|----------------------|
| Thermal Resistance (θ_{JC}) ⁽¹⁾ | $T_{BASE} = 85\text{ }^{\circ}\text{C}$, $V_D = +24\text{ V}$, $I_{DQ} = 600\text{ mA}$, | 2.97 | $^{\circ}\text{C/W}$ |
| Channel Temperature (T_{CH}) (Under RF drive) | Pulsed V_D : $PW = 100\text{ }\mu\text{s}$; $DC = 10\%$, | 162 | $^{\circ}\text{C}$ |
| Median Lifetime (T_M) | Freq = 9.25 GHz, $P_{IN} = 24\text{ dBm}$, $I_{D_Drive} = 1.7\text{ A}$, $P_{OUT} = 42\text{ dBm}$, $P_{DISS} = 25.9\text{ W}$ | 2.3E +09 | Hrs |
| Thermal Resistance (θ_{JC}) ⁽¹⁾ | $T_{BASE} = 85\text{ }^{\circ}\text{C}$, $V_D = +24\text{ V}$, $I_{DQ} = 600\text{ mA}$, CW, | 4.17 | $^{\circ}\text{C/W}$ |
| Channel Temperature (T_{CH}) (Quiescent, No RF) | $P_{DISS} = 14.4\text{ W}$ | 145 | $^{\circ}\text{C}$ |
| Median Lifetime (T_M) | | 1.5E +10 | Hrs |
| Thermal Resistance (θ_{JC}) ⁽¹⁾ | $T_{BASE} = 85\text{ }^{\circ}\text{C}$, $V_D = +24\text{ V}$, $I_{DQ} = 600\text{ mA}$, CW, | 4.05 | $^{\circ}\text{C/W}$ |
| Channel Temperature (T_{CH}) (Under RF drive) | Freq = 9.25 GHz, $P_{IN} = 24\text{ dBm}$, $I_{D_Drive} = 1.7\text{ A}$, | 183 | $^{\circ}\text{C}$ |
| Median Lifetime (T_M) | $P_{OUT} = 42\text{ dBm}$, $P_{DISS} = 24.2\text{ W}$ | 2.9E +08 | Hrs |
| Thermal Resistance (θ_{JC}) ⁽¹⁾ | $T_{BASE} = 85\text{ }^{\circ}\text{C}$, $V_D = +20\text{ V}$, $I_{DQ} = 600\text{ mA}$, | 2.75 | $^{\circ}\text{C/W}$ |
| Channel Temperature (T_{CH}) (Under RF drive) | Pulsed V_D : $PW = 100\text{ }\mu\text{s}$; $DC = 10\%$, | 136 | $^{\circ}\text{C}$ |
| Median Lifetime (T_M) | Freq = 9.25 GHz, $P_{IN} = 24\text{ dBm}$, $I_{D_Drive} = 1.6\text{ A}$, $P_{OUT} = 41.3\text{ dBm}$, $P_{DISS} = 18.5\text{ W}$ | 4.2 +10 | Hrs |
| Thermal Resistance (θ_{JC}) ⁽¹⁾ | $T_{BASE} = 85\text{ }^{\circ}\text{C}$, $V_D = +20\text{ V}$, $I_{DQ} = 600\text{ mA}$, CW, | 4.08 | $^{\circ}\text{C/W}$ |
| Channel Temperature (T_{CH}) (Quiescent, No RF) | $P_{DISS} = 12\text{ W}$ | 134 | $^{\circ}\text{C}$ |
| Median Lifetime (T_M) | | 5.3E +10 | Hrs |
| Thermal Resistance (θ_{JC}) ⁽¹⁾ | $T_{BASE} = 85\text{ }^{\circ}\text{C}$, $V_D = +20\text{ V}$, $I_{DQ} = 600\text{ mA}$, CW, | 3.73 | $^{\circ}\text{C/W}$ |
| Channel Temperature (T_{CH}) (Under RF drive) | Freq = 9.25 GHz, $P_{IN} = 24\text{ dBm}$, $I_{D_Drive} = 1.56\text{ A}$, | 151 | $^{\circ}\text{C}$ |
| Median Lifetime (T_M) | $P_{OUT} = 41.4\text{ dBm}$, $P_{DISS} = 17.7\text{ W}$ | 7.6E +09 | Hrs |

Notes:

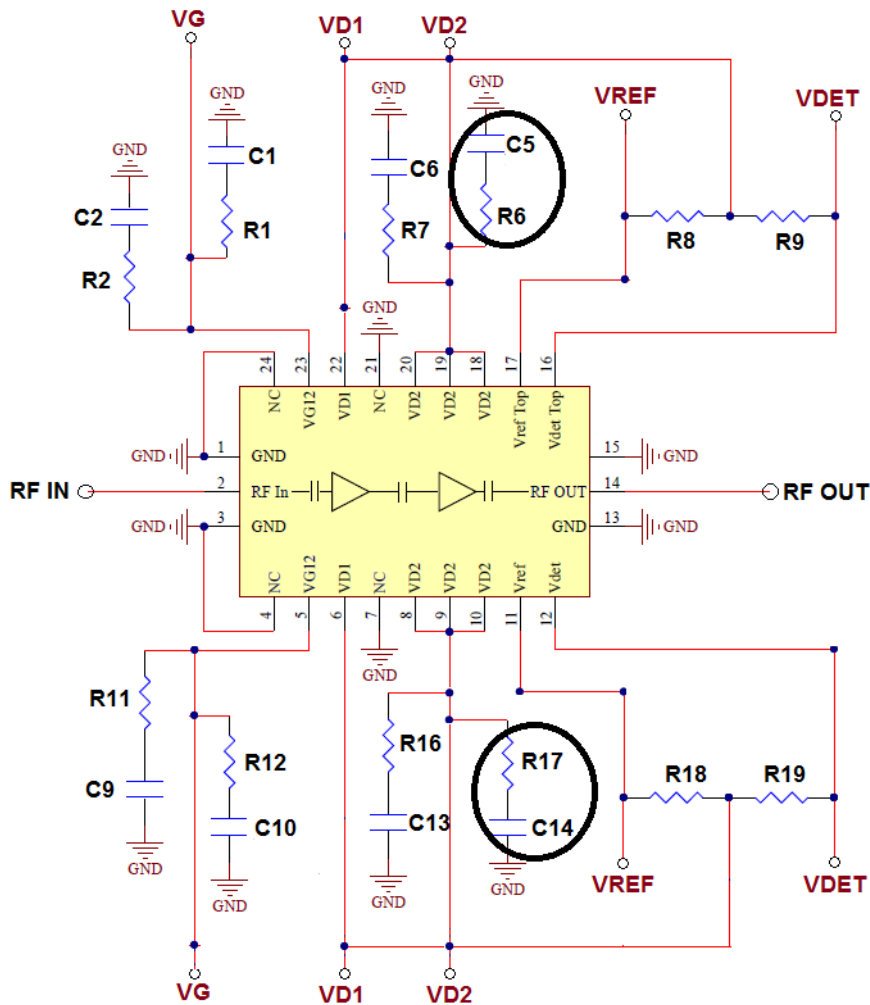
1. Thermal resistance is measured to the package backside.

Median Lifetime

Median Life Test Conditions: $V_D = +28\text{ V}$; Failure Criteria = 10% reduction in I_{D_MAX} during DC Life Testing



Applications Circuit for Linear and Pulsed Operations



Note: $V_{\Delta} = V_{REF} - V_{DET}$

- QPA1010 can be biased from either the top side or bottom side.
- V_{D1} and V_{D2} need to be tied together.
- V_{D1} / V_{D2} and V_{REF} / V_{DET} have to be on the same side for V_{Δ} to work.
- Bypassing components required for the side(s) being biased.
- The extra bias components (R6, R17, C5 and C14) are required for optimum linearity.

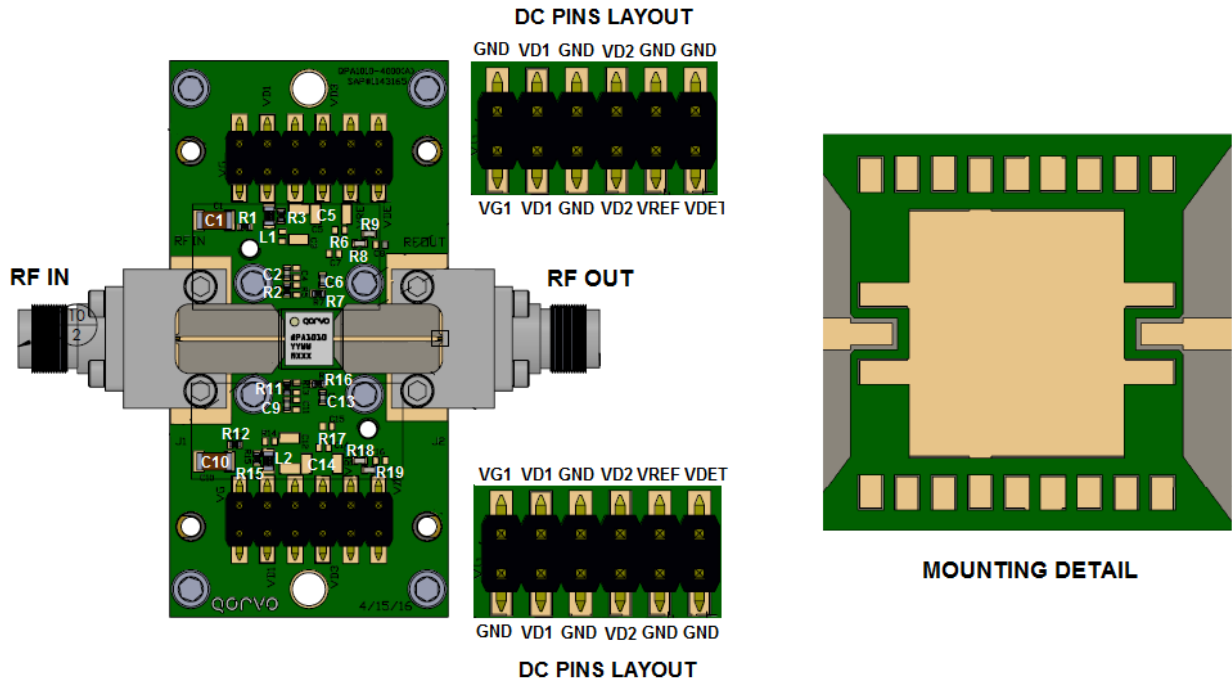
Bias Up Procedure

1. Set I_D limit to 2000 mA, I_G limit to 20 mA
2. Apply -5 V to V_G
3. Apply $+24\text{ V}$ to V_D ; ensure I_{DQ} is approx. 0 mA
4. Adjust V_G until $I_{DQ} = 600\text{ mA}$ ($V_G \sim -1.8\text{ V Typ.}$).
5. Turn on RF supply

Bias Down Procedure

1. Turn off RF supply
2. Reduce V_G to -5 V ; ensure I_{DQ} is approx. 0 mA
3. Set V_D to 0 V
4. Turn off V_D supply
5. Turn off V_G supply

Evaluation Board (EVB) Layout Assembly for Pulsed Operation



Note: PCB is a multilayer

1. All 4 metal thicknesses are 0.5 oz
2. Upper core 1 is Rogers 4003C, 8 mil thick
3. Lower core 2 is 370HR, 6 mil thick
4. Pre-Preg is an epoxy coated glass fabric
5. Total finished PCB thickness is 25 ±3 mil
6. This EVB uses a copper-coined PCB for optimum thermal management under high dissipation long pulse and/or CW conditions

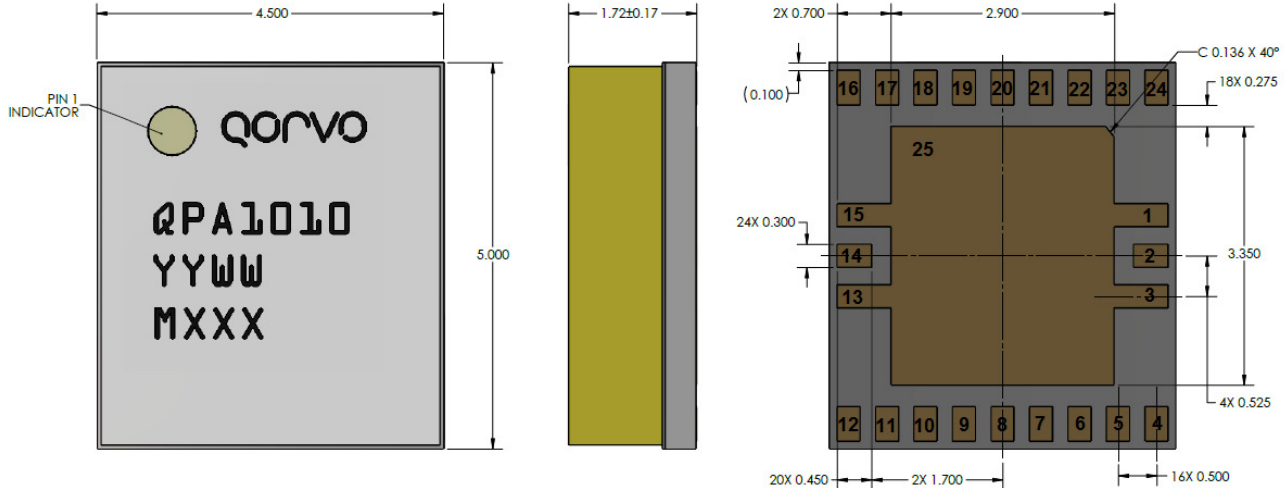
Bill of Materials for EVB

| Reference Des. | Value | Description | Manuf. | Part Number |
|---|------------|----------------------------|---------|-------------|
| C1, C5, C10, C14 | 10 uF | CAP, 1206, 50 V, 20 %, X5R | Various | – |
| C2, C6, C9, C13 | 0.01 uF | CAP, 0402, 50 V, 10 %, X7R | Various | – |
| R1, R12 | 5.1 Ohm | RES, 0402, 50V, 5 %, SMT | Various | – |
| R2, R3, R6, R7, R11, R15, R16, R17 ⁽¹⁾ | 0 Ohm | RES, 0402, 5 %, SMD | Various | – |
| R8, R9, R18, R19 | 25.5 K Ohm | RES, 0402, 1/16W, 1%, 0402 | Various | – |
| L1, L2 ⁽¹⁾ | 0 Ohm | RES, 0603, 1/10 W | Various | – |

Note:

1. These components are acting as the jumpers for this EVB.

Mechanical Information



Units: millimeters
 Tolerances: unless specified
 x.xx = ± 0.25
 x.xxx = ± 0.100
 Materials:
 Base: Laminate
 Lid: FR4
 All metalized features are gold plated
 Part is epoxy sealed
 Marking:
 QPA1010: Part number
 YY: Part Assembly year
 WW: Part Assembly week
 MXXX: Batch ID

Pin Description

| Pad No. | Symbol | Description |
|----------------------|-------------------|---|
| 1, 3, 13, 15, Center | GND | Ground. Must be grounded on the PCB. Conductive filled vias recommended for least inductance and improved thermal performance |
| 2 | RF _{IN} | RF Input; matched to 50 Ω; DC blocked |
| 4, 7, 21, 24 | N/C | Not connected internally. Recommended to be grounded |
| 5, 23 | V _{G1-2} | Stage 1-2 Gate Voltage. Bias network is required; see recommended Application Information above on page 21 |
| 6, 22 | V _{D1} | Stage 1 Drain Voltage. Bias network is required; see recommended Application Information above on page 21 |
| 8 – 10, 18 - 20 | V _{D2} | Stage 2 Drain voltage; Bias network is required; see recommended Application Information above on page 21 |
| 11, 17 | V _{REF} | Reference voltage |
| 12, 16 | V _{DET} | Detector voltage |
| 14 | RF _{OUT} | RF Output; matched to 50 Ω; DC blocked |